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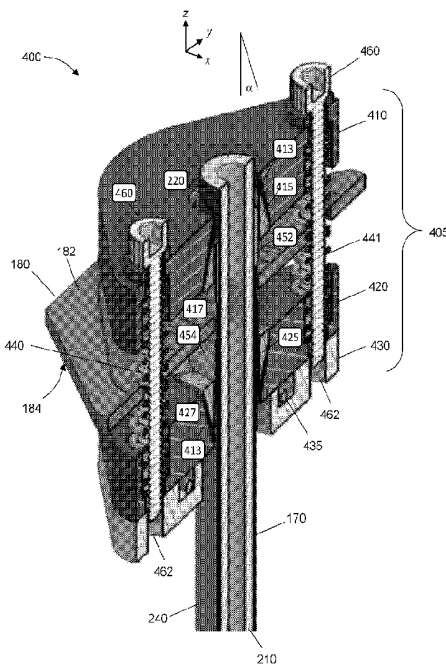


FIG. 4A

(57) Abstract: A heating system, related methods, and electrical connectors for same are described. The heating system employs one or more catalytic tubes, each having a reactive transmission line. Each catalytic tube is supported in a corresponding containment tube of a heater to produce heat. Heat can be generated by applying electrical pulses to the transmission lines which are exposed to a reactant flowing in the containment tube containing the catalytic tube. The generated heat can be extracted from the heater with a heat-transfer liquid or gas for various practical applications including, but not limited to, industrial, commercial, and residential heating applications.

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HEATING SYSTEMS AND METHODS AND ELECTRICAL CONNECTORS FOR SAME

CROSS-REFERENCE TO RELATED APPLICATIONS

[0001] The present application claims a priority benefit to U.S. provisional application serial no. 63/652,279, filed on May 28, 2024, entitled “Heating Systems and Methods,” U.S. provisional application serial no. 63/652,284, filed on May 28, 2024, entitled “Heating Systems and Methods,” and U.S. non-provisional application serial no. 19/073,990, filed March 7, 2025, entitled “Heating Systems and Methods.” Each of the foregoing applications is incorporated by reference herein in its entirety.

BACKGROUND

[0002] Efficient conversion of one form of energy to another form of energy is generally desirable and useful. For example, efficient conversion of solar energy to electrical energy is desirable and useful for commercial electric power providers as well as residential and industrial entities. Similarly, efficient conversion of chemical and/or electrochemical energy to one or more of mechanical energy, electrical energy, or thermal energy is desirable and useful for multiple industries.

[0003] Thermal energy (e.g., the internal kinetic energy within particles of a substance) plays an important role across various applications and industries where various heating, cooling and/or controlled temperature conditions are required. When applied to water and other fluids, thermal energy becomes an efficient medium for heat transfer and storage. The high specific heat capacity and widespread availability of water make it particularly suitable for applications that demand regulated thermal conditions. These properties have established heated water as a fundamental resource in fields such as energy production, manufacturing, chemical processing, food processing, HVAC systems, and environmental management.

[0004] The utility of thermal energy in heating water stems from water’s ability to absorb and retain heat efficiently, allowing it to serve as a thermal energy reservoir that can be used across multiple stages and processes. This makes water heating essential not only for direct applications but also as a secondary mechanism in broader systems, where controlled heating and cooling cycles are required to maintain operational stability, product quality, and energy efficiency.

[0005] The significance of heating water using thermal energy dates back to the Industrial Revolution, when steam engines powered by heated water created new opportunities for industry and transportation. The transformation of water into steam allowed for the development of machinery that drove mass production, powered locomotives, and laid the groundwork for modern industrial operations. The use of thermal energy to boil water and generate steam was one of the first major instances of harnessing controlled thermal processes on a large scale, creating a foundation for subsequent technological progress.

[0006] As boiler technology advanced, industries were able to harness water heating more safely and efficiently, enabling its use in a wider range of applications. By the mid-20th century, thermal energy in water heating had become an essential component in sectors from public utilities to private industrial systems, where it supported various manufacturing and energy production needs. Today, the role of thermal energy in water heating has expanded even further to include renewable energy sources, such as solar thermal and geothermal systems, highlighting the evolution of this technology in response to the increasing demand for sustainable and efficient energy solutions.

SUMMARY

[0007] The Inventors have recognized and appreciated that, as various industries continue to seek advancements in energy conservation and sustainability, improvements in the technology of water heating have become paramount. In particular, the need for one or both of precision or efficiency in heating solutions within multiple industries underscores the value of new technologies that can reduce energy consumption while providing thermal energy. As energy and environmental concerns continue to grow and the demand for thermal energy rises, virtually all industries are increasingly interested in innovative systems that generate and/or use thermal energy that offer greater efficiency, adaptability, sustainability and flexibility at various scales.

[0008] In view of the foregoing, the present disclosure is directed generally to inventive thermal energy generation systems and methods designed to heat fluids (e.g., water) based at least in part on electrically-stimulated catalytic reactions that convert electrical energy to thermal energy. Conventional water heating systems, such as resistive electric heaters and combustion-based boilers, are often hindered by energy inefficiencies, high operational costs, and negative environmental impacts. In contrast, the inventive systems and methods

disclosed herein take a fundamentally different approach by employing short, wideband electrical pulses to initiate exothermic reactions within one or more reactive layers of a specially-engineered catalyst. The inventive concepts described herein enable direct and efficient conversion of electrical energy to thermal energy and heat transfer to the surrounding fluid, thereby significantly enhancing energy utilization, significantly lowering overall energy consumption, and extending the system's operational lifespan. The inventive concepts described herein present a scalable and environmentally-friendly alternative to conventional heating systems, making the systems and methods disclosed herein well-suited for applications ranging from residential heating to large-scale industrial uses.

[0009] Unlike some conventional systems that rely on indirect heat transfer, the heat-generating catalytic reactions in examples of the inventive systems and methods disclosed herein occur directly within and/or on one or more reactive layers of one or more catalytic tubes, providing essentially immediate heat transfer to the fluid. This significantly reduces thermal energy losses often seen in resistive and combustion-based conventional heating systems, where a portion of the generated heat is lost to the surrounding environment or through intermediary materials. By positioning the heat source within one or more reactive layers of a catalytic tube, the inventive systems and methods disclosed herein achieve relatively higher energy utilization, making these systems and methods significantly more efficient than conventional systems and methods and reducing overall energy waste.

[0010] In example implementations of the inventive systems and methods disclosed herein, heat is generated in response to an electrical-pulse-driven activation mechanism. In particular, a pulse driver coupled to one or more catalytic tubes delivers relatively short, controlled bursts of electrical energy that stimulate catalytic reactions in the catalytic tube(s) when heat is needed. This example of an "on-demand" heating capability contrasts with conventional systems that often rely on a continuous energy input to maintain temperature. By operating predominantly (or in some instances exclusively) in response to heating requirements, a pulse-driven activation mechanism according to the inventive concepts disclosed herein reduces standby energy losses, ensuring that heat production aligns with real-time demand. This translates to greater energy conservation, reduced operational costs, and a smaller environmental footprint, making the technology particularly valuable for applications with fluctuating heating needs.

[0011] In yet another aspect, the pulse-driven activation mechanism provides significant precision in temperature control, a noteworthy advantage in industries that require strict thermal management (e.g., chemical processing, food production, and pharmaceuticals). By adjusting one or more of the frequency, amplitude, duty cycle and/or spectral content (e.g., pulse width) of the electrical pulses applied to one or more catalyst tubes, the systems and methods disclosed herein can fine-tune heat output, ensuring that the heated fluid reaches and effectively maintains the temperature necessary for a particular application with sufficient precision. Such precision significantly reduces risks of overheating or underheating, both of which are common in conventional systems that often struggle with responsive temperature control. The adaptability of the disclosed systems and methods across a wide range of fluid volumes and temperatures makes them suitable for residential, commercial, and industrial applications, positioning these inventive systems and methods as versatile and more effective solutions for diverse heating needs.

[0012] In some example implementations of the inventive systems and methods disclosed herein, another advantageous aspect relates to one or more integrated energy recovery features. For example, during the catalytic reactions, excess energy generated within one or more reactive layers of a catalytic tube can be captured and redirected back into the heating process. This reclaimed energy significantly increases thermal efficiency, reducing overall power consumption and enhancing performance. Unlike conventional heating systems and methods, which generally lack any mechanism to recapture “unused” thermal energy, such built-in recovery features allow the systems and methods disclosed herein to achieve exceptionally high energy utilization rates, thereby outperforming both resistive and combustion-based systems in energy-intensive settings. This capability offers additional savings and aligns with goals to significantly reduce environmental impact by seeking to utilize an appreciable portion, if not virtually all, of the thermal energy generated.

[0013] In yet another aspect of the inventive systems and methods disclosed herein, adverse emissions from thermal energy-generating reactions are significantly reduced, if not virtually eliminated in some examples, thereby reducing environmental impact. Traditional heating systems, particularly combustion-based models, present significant environmental concerns due to greenhouse gas emissions and pollutant byproducts. As noted above, the inventive concepts disclosed herein are employed to generate thermal energy through electrically-stimulated reactions rather than fuel combustion, which significantly reduces emissions. By

avoiding fossil fuel combustion, the systems and methods based on the inventive concepts disclosed herein significantly reduce emissions of carbon dioxide, nitrogen oxides, and particulate matter, offering a cleaner and more sustainable alternative. Even when powered by non-renewable electricity sources, the system's high efficiency results in a smaller environmental footprint compared to conventional systems. Furthermore, as it aligns with global efforts to transition toward renewable energy, the system is compatible with renewable power sources like solar and wind energy, further enhancing its sustainability profile.

[0014] In yet another aspect, systems and methods based on the inventive concepts disclosed herein emphasize longevity and reliability, particularly through the use of robust materials in the reactive layers of catalytic tubes. Materials such as nickel or other transition metals are chosen for their durability, high thermal conductivity, and resistance to degradation, allowing them to withstand repeated catalytic reactions without significant wear. In contrast, conventional heating elements, especially those exposed to high-temperature fluctuations, are prone to corrosion, mineral scaling, and eventual degradation. The durable design arising from the inventive concepts disclosed herein significantly reduces maintenance needs and system downtime, and extends the lifespan of the equipment, offering a cost-effective and long-lasting heating solution. The lower maintenance frequency not only enhances reliability but also reduces the overall cost of ownership.

[0015] In yet another aspect, the inventive concepts disclosed herein facilitate design of systems having a flexible and modular design, rendering these systems adaptable and scalable across a wide range of applications, from small residential uses to large-scale industrial processes. In residential settings, systems according to the inventive concepts disclosed herein provide a compact, efficient solution for household water heating (such as radiant floor heating, baseboard hot-water heating, radiator hot-water or steam heating, heated swimming pools, saunas, hot tubs, *etc.*), offering homeowners an eco-friendly and cost-effective alternative to traditional electric or gas water heaters. The pulse-driven catalytic design ensures that heat is only produced on demand, reducing standby losses typical in conventional home water heaters. Additionally, its energy efficiency and low maintenance requirements appeal to homeowners seeking to lower both energy bills and carbon footprint. For industrial applications, the system can be configured with larger catalytic tube arrays and advanced pulse control systems to meet high demands in factories, processing plants, and facilities that require continuous or high-capacity heating. Industrial settings, where

operational costs are heavily influenced by energy use, benefit from the system's high efficiency and reduced waste heat. Moreover, the precision control capabilities allow for consistent temperatures which is generally an important requirement in industries such as food processing, where exact heating conditions ensure product quality, safety, and regulatory compliance. Furthermore, in the context of flexible and modular designs of various sizes for diverse applications, it should be appreciated that one or more heat generating components according to the inventive concepts disclosed herein may be configured as a kit or assembly for retrofitting existing conventional heat generating devices and systems (e.g., conventional boilers) to significantly improve the performance of the conventional devices/systems.

[0016] As noted above, heating water with thermal energy is important for various manufacturing processes, where controlled heat application ensures product quality and operational efficiency. Industries such as metalworking, food processing, textiles, and chemicals depend heavily on thermal energy for numerous stages of production. In metalworking, processes such as annealing and quenching require heated water or other fluids to temper and strengthen metals, ensuring durability and resilience. Similarly, the food processing industry relies on heated water for pasteurization, sterilization, and cooking, where precise temperature control is essential to meet food safety standards and maintain product quality. In the textile industry, heated water is used extensively for dyeing and washing fabrics, ensuring that materials retain their color consistency and desired texture. Chemical manufacturing also requires a stable medium for heating, as controlled temperatures are important for facilitating consistent chemical reactions and ensuring high-quality outputs. The Inventors have recognized and appreciated that the inventive system and methods disclosed herein are well-suited all of the foregoing example applications and other applications, as discussed in greater detail below.

[0017] With respect to the food processing industry, the heating of water and other fluids is integral to operations requiring pasteurization, sterilization, cooking, blanching, and other temperature-sensitive processes. Thermal heating helps ensure food safety by maintaining the necessary temperatures to eliminate pathogens and spoilage organisms while preserving the food's quality, flavor, and nutritional value. For instance, pasteurization involves heating liquids to specific temperatures to kill harmful bacteria without compromising taste. Similarly, blanching uses heated water to deactivate enzymes in fruits and vegetables, which

preserves color and texture during processing and storage. Food processing facilities often face high energy costs due to the intensive heating demands required to maintain consistent temperatures, especially in large-scale operations. The inventive systems and methods disclosed herein are well-suited for multiple aspects of the food-processing industry including, but not limited to, pasteurizing, sterilizing, cooking and blanching.

[0018] As noted above, heating water with thermal energy also plays an important role in the chemical and refining industries, where it is used to control catalytic reactions, facilitate separation processes, and manage material extraction. In chemical manufacturing, precise temperature control is an important consideration, as variations can significantly impact reaction rates, product quality, and safety. Heated water provides a stable medium that enables manufacturers to maintain strict temperature parameters required for catalytic reactions and other sensitive processes. In petroleum refining, distillation is a core process that depends on thermal energy. By using heated water or steam, refineries can separate compounds based on their boiling points, effectively isolating valuable hydrocarbons, gases, and other resources. Extraction processes, such as those used in pharmaceutical production or essential oil extraction, also rely on heated water to control solubility and facilitate separation, underscoring the need for consistent and precise temperature regulation. The inventive systems and methods disclosed herein are well-suited for multiple aspects of the chemical and refining industries including, but not limited to, catalytic reactions, separation processes, distillation, and extraction.

[0019] Heating water with thermal energy also is valuable in environmental and agricultural contexts. For example, in agriculture, heated water is used to regulate temperatures within greenhouses, promoting optimal conditions for crop growth. Soil conditioning with heated water helps control pathogens and pests, allowing farmers to sterilize soil without relying on chemical interventions. In aquaculture, thermal energy regulates water temperatures essential for fish farming, where precise temperature ranges are important to species health, growth, and production efficiency. Environmental remediation efforts also benefit from heated water applications, where thermal energy aids in separating and neutralizing contaminants such as oil spills or chemical residues. The inventive systems and methods disclosed herein are well-suited for multiple aspects of environmental and agricultural applications including, but not limited to, greenhouse or aquaculture temperature control, soil conditioning, and contaminant remediation.

[0020] Thermal energy also is a central component of HVAC (heating, ventilation, and air conditioning) systems and general building infrastructure. Water heating is crucial for hydronic heating systems, such as radiators and underfloor heating, which circulate heated water to provide consistent warmth throughout residential and commercial buildings. These systems are commonly powered by boilers that generate efficient, reliable heat, making them cost-effective for building heating. Recent advancements in boiler technology, including tankless water heaters and heat pumps, have further optimized energy use in HVAC systems. Tankless systems, for example, provide on-demand heating, which reduces energy waste and lowers operational costs. Heat pump technology has also evolved to deliver both heating and cooling by utilizing thermal energy efficiently, and many of these systems are increasingly powered by renewable energy sources. The inventive systems and methods disclosed herein are well-suited for multiple aspects of HVAC and building environmental control.

[0021] All combinations of the foregoing concepts and additional concepts discussed in greater detail below (provided such concepts are not mutually inconsistent) are part of the inventive subject matter disclosed herein. In particular, all combinations of subject matter appearing in this disclosure are part of the inventive subject matter disclosed herein. The terminology used herein that also may appear in any disclosure incorporated by reference should be accorded a meaning most consistent with the particular concepts disclosed herein.

BRIEF DESCRIPTION OF THE DRAWINGS

[0022] The skilled artisan will understand that the drawings primarily are for illustrative purposes and are not intended to limit the scope of the inventive subject matter described herein. The drawings are not necessarily to scale; in some instances, various aspects of the inventive subject matter disclosed herein may be shown exaggerated or enlarged in the drawings to facilitate an understanding of different features. In the drawings, like reference characters generally refer to like features (e.g., functionally and/or structurally similar elements).

[0023] **FIG. 1A** depicts a heating system that comprises catalytic tubes to heat a liquid and/or gas flowing through the heating system.

[0024] **FIG. 1B** depicts, in perspective view, an example of a heater that can be used in the heating system of **FIG. 1A**.

[0025] FIG. 2A depicts an example of a catalytic tube that includes a reactive transmission line and that can be used in the heating system of FIG. 1A.

[0026] FIG. 2B illustrates a cross-section of the catalytic tube of FIG. 2A.

[0027] FIG. 2C depicts, in cross-section, the catalytic tube of FIG. 2B installed within a containment tube.

[0028] FIG. 2D depicts another implementation of a reactive transmission line structure and catalytic tube that can be used in the heater of FIG. 1A.

[0029] FIG. 2E illustrates a portion of the catalytic tube of FIG. 2B in finer detail.

[0030] FIG. 2F depicts another catalytic structure comprising reactive transmission lines that can be used in the heater of FIG. 1A.

[0031] FIG. 3A depicts further details of a portion of the heating system of FIG. 1A where the catalytic tube passes through an end of the heater.

[0032] FIG. 3B illustrates an expanded cross-sectional view of a portion of FIG. 3A showing various components at one end of a tubular portion of a containment tube of the heater shown in FIG. 3A.

[0033] FIG. 3C depicts an example of a cooling plate that can cool components at the ends of the containment tubes of FIG. 3A.

[0034] FIG. 4A depicts an electrical connector that attaches near an end of the catalytic tube of FIG. 2A.

[0035] FIG. 4B depicts an example of a transmission line and contact that can be formed on a PCB used with the electrical connector of FIG. 4A.

[0036] FIG. 4C illustrates further details of collets used in the electrical connector of FIG. 4A to make electrical connections to a transmission line formed on the catalytic tube.

[0037] FIG. 4D is a cross-sectional, perspective view of a collet used in the electrical connector of FIG. 4A.

[0038] FIG. 4E depicts an end of a catalytic tube that can be inserted into the electrical connector of FIG. 4A.

[0039] FIG. 5 illustrates another implementation of a heater that can be used in the heating system of FIG. 1A.

[0040] FIG. 6A depicts circuitry connected to a catalytic tube.

[0041] FIG. 6B depicts another view of the circuitry of FIG. 6A connected to the catalytic tube.

[0042] FIG. 7 is a flow diagram illustrating steps involved in making a catalytic tube.

DETAILED DESCRIPTION

[0043] Following below are more detailed descriptions of various concepts related to, and implementations of, heating systems and methods. It should be appreciated that various concepts introduced above and discussed in greater detail below may be implemented in numerous ways. Examples of specific implementations and applications are provided primarily for illustrative purposes so as to enable those skilled in the art to practice the implementations and alternatives apparent to those skilled in the art.

[0044] The figures and example implementations described below are not meant to limit the scope of the present implementations to a single embodiment. Other implementations are possible by way of interchange of some or all of the described or illustrated elements. Moreover, where certain elements of the disclosed example implementations may be partially or fully implemented using known components, in some instances only those portions of such known components that are necessary for an understanding of the present implementations are described, and detailed descriptions of other portions of such known components are omitted so as not to obscure the present implementations.

[0045] In the discussion below, various examples of heating systems and methods are provided, wherein a given example showcases one or more particular features in a given context. It should be appreciated that one or more features discussed in connection with a given example may be employed in other examples according to the present disclosure, such that the various features disclosed herein may be readily combined in a given system according to the present disclosure (provided that respective features are not mutually inconsistent).

[0046] The Inventors have recognized and appreciated that reactions in catalytic tubes through which a reactant flows can be stimulated by temporally short, wideband electrical

pulses. In some cases, the stimulated reactions can efficiently produce heat which can be transferred to a heat-transfer substance that flows in close proximity to and/or in contact with the catalytic tubes. The catalytic tubes can be incorporated into a heating system designed to heat the heat-transfer substance that flows through the system. Such a system can be used, for example, to efficiently produce heated water for commercial and residential heating applications (such as domestic hot water, radiant floor heating, baseboard hot-water heating, radiator hot-water or steam heating, heated swimming pools, saunas, hot tubs, *etc.*), though heating of other liquids or gases for other applications are also possible. For example, in some cases the stimulated reactions can be hydrogenation reactions that are used to form a substance, such as for the food or chemical industries.

[0047] 1. Heating System

[0048] FIG. 1A depicts an example of a heating system 100 that comprises a heater 110 having catalytic tubes 170 to heat at least one heat-transfer substance (a fluidic substance such as a liquid and/or gas) flowing through the heater 110. The catalytic tubes 170 extend through the heater 110 and are located within containment tubes 117, which also extend through the heater 110. The illustrated heating system 100 further comprises a pump 120, an electronic pulse driver 150, a reactant processing system 140, and a controller 190. The heat-transfer substance output from the heater 110 can be provided to a thermal load 160. In some implementations, the thermal load 160 can be a hot-water system for a commercial or residential application (*e.g.*, domestic hot water, radiant floor heating, baseboard hot-water heating, radiator hot-water or steam heating, heated swimming pools, saunas, hot tubs, *etc.*). In such implementations, the heater 110 can heat the water that is distributed by the hot-water system.

[0049] The controller 190 can be communicatively coupled, through wireless and/or wired links, to at least one other component in the heating system 100 to implement monitoring and/or control functionality for the heating system 100. The controller 190 can comprise at least one processing device and may comprise a combination of processing devices. Example processing devices that can be used in the controller 190 include, but are not limited to: microprocessor, microcontroller, programmable logic controller (PLC), field-programmable gate array (FPGA), digital signal processor (DSP), application-specific integrated circuit (ASIC), digital logic chips, and transistors. In some cases, the controller 190 can further include discrete electronic components (*e.g.*, resistors, capacitors, inductors, *etc.*), at least one

display element (*e.g.*, light indicator, liquid-crystal display (LCD), an LCD or LED monitor, a touchscreen, *etc.*), and at least one input element (*e.g.*, a touchscreen, keypad or keyboard, button, switch, *etc.*). In some implementations, the controller 190 comprises a tablet computer, laptop computer, smartphone, or other packaged computing device. The controller can be co-located with the heating system 100 (*e.g.*, attached to the heater 110), or can be located remotely from the heating apparatus (*e.g.*, communicatively coupled over a network, such as a local area network or wide area network). In some implementations, portions of the controller 190 can be co-located with the heating system 100 and portions of the controller 190 can be located remotely from the heating apparatus.

[0050] In the illustration of **FIG. 1A**, the controller 190 is communicatively coupled to the heater 110, the pump 120, the reactant processing system 140, the pulse driver 150, and the thermal load 160. Each of these communicative couplings can include one or more control lines or channels for issuing control signals to a connected device. Additionally, or alternatively, there can be one or more sense lines or channels to communicatively couple the controller 190 to one or more sensors and one or more of the connected devices (*e.g.*, heater 110, pump 120, reactant processing system 140, and pulse driver 150) in the heating system 100. The sense lines or channels can be used to receive data from the connected sensor or connected device.

[0051] The pump 120 can comprise a liquid or gas pump that is operated to circulate a heat-transfer substance through the heater 110 and thermal load 160. The heat-transfer substance can flow out at least one output heat-transfer port 116 from the heater 110 and via at least one output heat-transfer line 165 through the thermal load 160. Cooled heat-transfer substance can return from the thermal load 160 via at least one return heat-transfer line 164 to at least one input heat-transfer port 112 and thus flow back into the heater 110 for reheating and continued circulation. In some cases, one or more output heat-transfer lines 165 and one or more return heat-transfer lines 164 can connect to one or more of the catalytic tubes 170 and to the thermal load 160 for additional heat transfer, as described further below in connection with the catalytic tubes.

[0052] The reactant processing system 140 can manage flow of a reactant gas or liquid for the catalytic tubes 170. The reactant processing system 140 can include a reservoir to hold the reactant gas or liquid. The reactant processing system 140 can include at least one pump to circulate the reactant gas or liquid through or over the catalytic tubes 170 and through

apparatus within the reactant processing system 140 (such as filters). The reactant processing system 140 can include various apparatus to process the reactant gas or liquid (*e.g.*, one or more filters, gas sensors, pressure regulators, *etc.*). The reactant gas or liquid can be provided to one or more catalytic tubes 170 in the heater 110 via at least one reactant input line 144 and at least one reactant input port 113 and return to the reactant processing system 140 via at least one reactant output port 115 and at least one reactant return line 145.

[0053] The electronic pulse driver 150 is configured to output electrical excitation pulses to at least one catalytic tube 170 in the heater 110. In some implementations, there can be more than one electronic pulse driver 150 per heater 110. For example, each catalytic tube can have a dedicated electronic pulse driver 150 connected to it. The electronic pulse driver 150 is configured to output sequences of temporally short, broad frequency spectrum pulses (also referred to as Q pulses) to excite reactions in the catalytic tubes and thereby cause the generation of heat in the catalytic tubes 170. The electronic pulse driver 150 can be used to turn on and turn off heat generation by the heater 110. Examples of drive circuitry for an electronic pulse driver 150 are described in U.S. patent No. 8,624,636 titled “Drive Circuit and Method for Semiconductor Devices,” issued January 7, 2014, which patent is herein incorporated by reference in its entirety.

[0054] In some implementations, the pulse driver 150 can be configured to produce excitation pulses that each rise quickly from an initial value to a peak value, sustain approximately the peak value for a period of time, and fall back to the initial value. Examples of such pulses are square pulses, though other pulse shapes are possible. The excitation pulses can be output from the pulse driver 150 at a repetition frequency f with a duty cycle D (ratio of the pulse’s on time to period $T = 1/f$). The rise time τ_r of the excitation pulses can be less than approximately or exactly 50 ns (*e.g.*, between approximately or exactly 1 ns and approximately or exactly 50 ns), though shorter rise times can be used in some implementations. The repetition frequency f can be between approximately or exactly 1 kHz and approximately or exactly 500 kHz and the duty cycle D can be between approximately or exactly 0.5% and 50%. The peak amplitude of the excitation pulses can be between approximately or exactly 20 V and approximately or exactly 1000 V.

[0055] In some cases, the pulse driver 150 can be configured to produce excitation pulses that each rise to a peak value and fall to an initial value without a sustained duration of the peak value. Examples of such excitation pulses are Gaussian pulses, though other pulse

shapes are possible. The temporal full-width-half-maximum value τ_0 of the excitation pulses can be less than approximately or exactly 200 ns (*e.g.*, between approximately or exactly 1 ns and approximately or exactly 200 ns), though shorter excitation pulses can be used in some implementations. The repetition frequency f can be between approximately or exactly 1 kHz and approximately or exactly 500 kHz and the duty cycle D can be between approximately or exactly 0.5% and 50%. The peak amplitude of the excitation pulses can be between approximately or exactly 50 V and approximately or exactly 1000 V.

[0056] The Inventor has recognized and appreciated that the application of pulses to the transmission line of the catalytic tube 170 can produce phonons in the lattice of the catalyst material. These phonons shake the lattice and can trigger heat-producing reactions catalyzed by the lattice material. More abrupt rise times and/or shorter pulse durations of the applied electrical pulses comprise a broader band of frequencies that can excite the lattice and increase reactivity of the catalytic tube 170.

[0057] The electrical pulses from the electronic pulse driver 150 can be applied to the catalytic tubes 170 via transmission lines 152, 154, which can be implemented as radio-frequency (RF) coaxial cables. In some cases, the transmission lines 152, 154 can connect to printed circuit boards (PCB) 180a, 180b (also referred to as “coupling PCB 180a, 180b” or more generally as “coupling PCB 180”) which in turn electrically couple to the catalytic tubes 170. According to some implementations, as illustrated in **FIG. 1A**, the electronic excitation pulses can be applied via a first transmission line 152 to an end of a first one of the catalytic tubes 170, travel down the first catalytic tube to an opposing end and then be applied via a second transmission line 154 to an end of a second one of the catalytic tubes 170. In this manner, the electronic excitation pulses can be applied to all of the catalytic tubes 170 (which are connected in series) in the heater 110. In some cases, the pulse driver 150 can output pulses for exciting reactions in at least two catalytic tubes 170 that are connected in series (*e.g.*, from 2 to 8, from 5 to 20, or more than 20). In some cases, the pulse driver 150 can provide excitation pulses to more than 8 catalytic tubes 170 that are connected in series. In some implementations, the pulse driver 150 can provide excitation pulses to multiple catalytic tubes 170 that are connected in parallel (*e.g.*, from 2 to 8, from 5 to 20, or more than 20).

[0058] **FIG. 1B** illustrates, in perspective view, an example of a heater 110 that can be used in the heating system of **FIG. 1A**. The heater is tipped to show an end of the heater 110.

There are four containment tubes 117 extending from each end of the heater 110 which can house four catalytic tubes 170 (not shown in **FIG. 1B**), though a heater 110 can have fewer or more containment tubes 117 than shown in the drawing. The heater comprises an outer shell 119 and feed-thru manifolds 114 located at each end of the heater 110. To reduce heat loss to the external environment and increase an amount of heat coupled to heat-transfer liquid or gas flowing through the heater, the heater 110 can be wrapped in insulation and/or heat-reflective material and covered with a thin layer of sheet metal, polymer, or other material (not shown in the drawing) in an arrangement similar to household hot water heaters. The length L of the heater 110 can be from 50 cm to 200 cm, though shorter or longer heaters can be implemented.

[0059] 2. Catalytic Tubes

[0060] FIG. 2A and FIG. 2B depict an example of a catalytic tube 170 that can be used in the heating system of **FIG. 1A**. **FIG. 2B** illustrates a cross-section (taken at the dashed line) of the catalytic tube 170 of **FIG. 2A**. In this illustrated implementation, the catalytic tube 170 comprises a support 210 and several layers of material deposited on the support. The support 210 can be formed from an electrically conductive or non-conductive material that is able to withstand temperatures of up to 800 °C without permanently deforming or being damaged. The layers deposited on the support 210 can include, but are not limited to, an electrically-conductive layer 220, an electrically-insulating layer 230 disposed on the electrically-conductive layer 220, and an electrically-conductive, reactive layer 240 disposed on the electrically-insulating layer 230. In some implementations, a second electrically-insulating layer can be deposited between the support 210 and the electrically-conductive layer 220, to increase electrical and/or thermal isolation of the support 210 from the outer layers.

[0061] The phrase “disposed on” can mean that a second layer physically contacts an underlying first layer (*e.g.*, is physically deposited on and is in intimate contact with the underlying first layer). The phrase “disposed on” also can mean that a second layer is disposed over the underlying first layer with at least one intervening layer between the first layer and second layer.

[0062] The support 210 can be a cylindrical tube or have another shape (*e.g.*, a square tube, rectangular tube, polygonal tube, or elliptical tube). The support 210 can extend at least the

length L of the heater and can further extend beyond each end of the heater 110 when installed in a containment tube 117 of the heater 110. The support 210 can have an interior wall 212 surrounding a hollow core 205. In other implementations, the support 210 may not have a hollow core and instead be solid or porous at its interior region. When the support 210 has a porous or hollow core 205, a heat-transfer substance (*e.g.*, a liquid or gas) can be circulated through the hollow core 205 and through a thermal load 160 with additional fluidic connections between the catalytic tubes 170, the thermal load 160. The heat-transfer substance can be circulated with the same pump 120 or an additional pump.

[0063] According to some implementations, the support 210 is formed from a metal (*e.g.*, stainless steel). Other materials that can be used to make the support 210 include, but are not limited to, invar, Zerodur®, a ceramic, alumina, fused silica or other glass, zirconia, and sapphire. In some implementations, the outer diameter d or maximum transverse dimension of the support 210 or catalytic tube 170 can be between approximately or exactly 2.5 mm and approximately or exactly 12 mm, though larger diameters may be used in some cases.

[0064] Having a small diameter can be beneficial for obtaining a high peak current density (about 2 kA/mm²) in the reactive layer 240 for a pulse driver 150 operating with voltages below 1000 volts. For some applications, the peak current density driven in the reactive layer 240 by the pulse driver 150 is between approximately or exactly 1.5×10^3 A/mm² and 3×10^3 A/mm². For a pulse driver 150 operating at higher voltages and/or supplying higher currents, the support 210 can have larger diameters or transverse dimensions (*e.g.*, up to 25 mm or even larger). The length of the support 210 (along the z direction in the drawings) can be between approximately or exactly 40 cm and approximately or exactly 220 cm. With smaller diameters, more than four containment tubes 117 (and catalytic tubes 170 installed therein) can be mounted in the heater 110 to increase heat output. For example, up to 100 containment tubes 117 and catalytic tubes 170 could be assembled into a heater 110.

[0065] FIG. 2C depicts a cross-section of the catalytic tube 170 of FIG. 2B installed within the containment tube 117. An annular reactant space 250 exists between the outer surface 242 of the catalytic tube 170 and in inner surface 111 of the containment tube 117. A reactant gas or liquid can flow along the catalytic tube 170 in a sheath over the outer surface 242 and contact the outer surface of the catalytic tube. In this illustrated implementation, the flowing reactant can contact the electrically-conductive, reactive layer 240 of the catalytic tube 170.

[0066] For some materials, such as stainless steel, the support 210 and catalytic tube 170 of **FIG. 2A** may undesirably sag when operating at temperatures up to 800 °C (*e.g.*, when the catalytic tube is mounted such that its length is oriented horizontally in a heater installation). To prevent sag, the annular reactant space 250 between the reactive layer 240 of the catalytic tube 170 and the inner wall of the containment tube 117 (when the catalytic tube 170 is installed inside the containment tube 117) can be packed with a porous, thermally-conductive fill material, such as alumina. The containment tube 117 can then provide additional support to the catalytic tube 170. The porous material can still allow flow of the reactant within the annular reactant space 250.

[0067] In other implementations, the structure of the catalytic tube can be different than that shown. In one example, the structure of the catalytic tube is reversed from that shown in **FIG. 2B**, such that the support tube is located on the outside of the catalytic tube 170 and the layers are deposited on the interior of the outer support such that the electrically-conductive, reactive layer is in inner most layer adjacent to the hollow core 205. In this implementation, the reactant can flow through the hollow core 205. The containment tube 117 can be omitted from the heater 110 in such an implementation so that the heat-transfer substance contacts the outer support tube.

[0068] In another example, illustrated in **FIG. 2D**, an insulating tube (such as a fused quartz tube) 232 can be used to provide support for the catalytic tube 170, provide electrical isolation between the conductive layers, and form the reactive transmission line with the electrically-conductive layer 220 and electrically-conductive, reactive layer 240. The containment tube 117 can be included in the heater 110 if the electrically-conductive, reactive layer 240 is located on the outside of the catalytic tube 170, as illustrated. Alternatively, the containment tube 117 can be omitted from the heater 110 if the electrically-conductive, reactive layer 240 is located on the inside of the catalytic tube 170 (an order of layers reversed from the order shown in **FIG. 2D**).

[0069] Because of high-temperature operation, it is desirable to use a material for the support that has a very low coefficient of thermal expansion (CTE) or one that approximately matches a CTE for at least one layer, or for the combination of layers, deposited on the support 210. For example, the CTE of the support 210 can approximately match a CTE for at least one of, or the combination of, the electrically-conductive layer 220, the electrically-insulating layer 230, and the electrically-conductive, reactive layer 240. Differences in CTE

values between the support 210 and layers may limit the length of the catalytic tubes 170 (*e.g.*, due to cracking and/or delamination of the layers deposited on the support 210). For lower temperature operation (*e.g.*, in domestic water heaters where the catalytic tubes 170 may operate at temperatures no greater than about 200 °C) design considerations relating to either or both of catalytic tube sag (described above) and differences in CTE values can be more relaxed. For example, larger CTE differences may be tolerated and/or a support 210 that may sag at 800 °C may operate fine at 200 °C without sagging.

[0070] For one example implementation, the support 210 is formed from alumina (CTE: $8.1 \times 10^{-6}/^{\circ}\text{C}$) or austenitic stainless steel (CTE: $17.3 \times 10^{-6}/^{\circ}\text{C}$), the electrically-conductive layer 220 is formed from copper (CTE: $\sim 16.4 \times 10^{-6}/^{\circ}\text{C}$), the electrically-insulating layer 230 is formed from alumina, and the electrically-conductive, reactive layer 240 is formed from nickel (CTE: $13 \times 10^{-6}/^{\circ}\text{C}$). Other material combinations are possible.

[0071] Referring again to **FIG. 2B**, the outer surface 218 of the support 210 (over at least a region on which the outer layers are deposited) can be machined and/or polished smooth so that subsequent layers deposited on the outer surface 218 will be smooth. The electrically-conductive layer 220, the electrically-insulating layer 230, and the electrically-conductive, reactive layer 240 can form a transmission line 270 suitable for propagating electrical excitation pulses (delivered by the electronic pulse driver 150) along the catalytic tube 170 which stimulate a catalytic reaction with the reactant gas or liquid that contacts the electrically-conductive, reactive layer 240 of the transmission line 270. Such a transmission line may be referred to as a “reactive transmission line” or “catalyzing transmission line.” When the support 210 is cylindrical, the transmission line 270 formed by the three outer layers is a coaxial transmission line, though other transmission line shapes can be used in other implementations. A smooth outer surface 218 of the support and of the electrically-insulating layer 230 can improve transmission line performance (*e.g.*, reduce dispersion of excitation pulses propagating along the catalytic tube). A smooth and dense outer surface of the electrically-insulating layer can also reduce the dispersion of phonons generated in the electrically-conductive, reactive layer 240 and increase the reflection of phonons emanating from the electrically-conductive, reactive layer 240 back into the electrically-conductive, reactive layer 240 to improve catalytic reactions in the layer. In some implementations, the RMS roughness of the outer surface 218 can be between approximately or exactly 0.1 micron and approximately or exactly 1 micron, or between approximately or exactly 0.05 micron and

approximately or exactly 0.5 micron. Preferably, the short pulse shape and high peak intensity should be maintained as the excitation pulse propagates along the catalytic tube(s) 170.

[0072] By making the outer surface 218 of the support 210 smooth, the deposited electrically-conductive layer 220 can be smooth to help reduce dispersion of excitation pulses propagating along the catalytic tube 170. The thickness of the electrically-conductive layer 220 can be between approximately or exactly 1 micron and approximately or exactly 500 microns, though thinner or thicker values may be used in some cases. The electrically-conductive layer 220 can be deposited by a physical deposition process (*e.g.*, a plasma spray deposition or chemical vapor deposition) and/or by a plating process (*e.g.*, electrochemically plated onto the support 210). According to some implementations, the electrically-conductive layer 220 is formed using multiple steps. First, the selected material (*e.g.*, copper) is spray deposited in a reduction atmosphere to improve adhesion to the support 210. The spray deposition also can provide a porous morphology of the deposited layer to help accommodate differences in CTEs between the deposited layer and the support 210. In a next step, the same conductive material or a different conductive material can be plated onto the spray-deposited material to form a smooth skin through which electrical current will flow (driven by the pulse driver 150) when the system is in operation.

[0073] The electrically-insulating layer 230 can comprise a dielectric material, such as alumina, yttrium stabilized zirconia, or other dielectric material. Preferably, the dielectric material can withstand high temperatures (*e.g.*, up to 800 °C) without incurring an appreciable change (*e.g.*, more than 5%) in the dielectric constant or permittivity of the dielectric material. Alumina can withstand such high temperatures and maintain its dielectric constant to within about 5% between room temperature and high temperature operation up to 800 °C. The electrically-insulating layer 230 can be spray coated in particulate form onto the electrically-conductive layer 220. The spray deposition can provide some porosity of the deposited layer (to accommodate differences in CTE values between the electrically-insulating layer 230 and adjacent layers. The thickness of the electrically-insulating layer 230 can be between approximately or exactly 100 microns and approximately or exactly 400 microns, though thinner or thicker values may be used in some cases.

[0074] The reactive layer 240 can be deposited onto the electrically-insulating layer 230 using a physical deposition process (*e.g.*, sputtering, plasma spray deposition, chemical vapor

deposition, application of a powder form of the material and sintering) and/or an electroplating process. This outer layer comprises a reactive layer where heat is generated during operation of the heater. The material for the reactive layer 240 is chosen to catalyze a reaction with the reactant substance that contacts the reactive layer 240. In some implementations, atoms of the reactant substance (such as hydrogen atoms or deuterium atoms) can enter and diffuse into the lattice of the reactive layer 240. Example materials for the reactive layer 240 include, but are not limited to, nickel (Ni), copper (Cu), palladium (Pd), platinum (Pt), rhodium (Rd), titanium (Ti), tungsten (W), cobalt (Co), iron (Fe), any transition metal that can absorb hydrogen, or some combination these materials formed in an alloy and/or multilayer structure. In some implementations, the reactive layer 240 can be formed as a multilayer structure (*e.g.*, a thin, micron or sub-micron thick layer of Pd deposited over Ni). Such a multilayer structure may improve absorption of hydrogen into nickel.

[0075] In an exemplary implementation, Ni used. Nickel has several desirable features which include low cost and suitability for physical deposition processes. Another desirable feature of Ni is that absorption of hydrogen within the material increases when the temperature of the material increases, which is an opposite trait than absorption of hydrogen in Pd. In some implementations, the deposited nickel can be treated to form a porous or so-called “grainy nickel” which can provide a more reactive surface and facilitate ingress of atoms from the reactant substance into the reactive layer 240.

[0076] The thickness of the reactive layer 240 can be between approximately or exactly 200 micron and approximately or exactly 900 microns, though thicker values may be used in some cases. The reactive layer 240 can be deposited to a thickness that is sufficient to dissipate heat generated from catalyzed reactions within the layer without damage to the layer. As such, the thickness of the reactive layer 240 may be selected based on a peak temperature expected for a particular application. An application for producing domestic hot water or for a hydrogenation process may operate at a lower temperature than an application for heating systems to heat a residential or commercial building and therefore have catalytic tubes 170 with thinner reactive layers (*e.g.*, no greater than 200 microns).

[0077] A countervailing consideration for the thickness of the reactive layer 240 is diffusion of atoms from the reactant gas or liquid into the reactive layer. Preferably, the reactive layer 240 is thin enough so that a sufficient supply of atoms (*e.g.*, hydrogen atoms) can diffuse into

the reactive layer 240 to an active portion of the reactive layer. During operation of the heating system 100, the reactive layer 240 is exposed to both the reactant which flows across the outer surface of the reactive layer 240 due to the reactant processing system 140 and to electrical current from broad-spectrum excitation pulses delivered by the electronic pulse driver 150. Because of the skin effect, the current flowing through the reactive layer 240 can be confined within a short distance δ from the interface between the electrically-insulating layer 230 and the reactive layer 240, as depicted in **FIG. 2E**. This short distance δ is a region within which catalyzed reactions can be highest and is part of the active portion of the reactive layer 240.

[0078] The distance δ , known as the skin depth, is determined in part by the frequency (or frequency spectrum) of the excitation pulse driven along the transmission line 270 by the pulse driver 150 and the resistivity of the material used to form the reactive layer 240. Both the frequency spectrum and resistivity can be tailored, to some extent, during design and/or operation of the system. For example, the excitation pulse duration can be tailored during design of the pulse driver 150 and may be adjustable by a user during operation of the system in some implementations of the pulse driver. The pulse amplitude (and therefore pulse energy and average power in a train of pulses) may also be adjustable by a user during operation of the system. The resistivity of the reactive layer 240 can be tailored by alloying metals and/or by selecting or adjusting deposition processes during design and manufacture of the catalytic tubes 170, for example.

[0079] To obtain uniform layer thicknesses for each of the three layers 220, 230, 240 during a physical deposition process, the support 210 can be rotated (about its central axis along the z direction) and may further be translated within a deposition chamber.

[0080] During operation of the system, most of the current from the excitation pulses provided by the pulse driver 150 flows within the region bound by the skin depth δ . In this region, the driven current can excite phonons in the reactive layer 240. The phonons can propagate throughout the reactive layer 240 dissipating energy to the lattice as they propagate. These phonons have their highest energy in the region of the reactive layer 240 bound by the skin depth and they aid in stimulating reactions of the reactant gas or liquid catalyzed by the reactive layer 240. The active portion of the reactive layer 240 can extend beyond the skin depth since phonons can propagate beyond the skin depth. The catalyzed reactions produce heat in the reactive layer 240 that, in part, radiates outward to the

surrounding containment tube 117 where the heat can thermally couple to the heat-transfer substance in the heater 110.

[0081] At the ends of the catalytic tube 170, along portions of the catalytic tube that extends outside the heater shell 119, the electrically-conductive layer 220 can be exposed along a first length L_1 of the support 210 (in the $\pm z$ directions of the drawing for **FIG. 2A**), so that an electrical connection can be made to the electrically-conductive layer 220. Similarly, the reactive layer 240 can also be exposed along at least a second length L_2 of the support 210 so that an electrical connection can be made to that layer. The electrically-insulating layer 230 may or may not be exposed along a length of the support 210.

[0082] Other implementations of a catalytic structure are also possible, and a tube shape is not necessarily required. In some cases, the catalytic structure can be implemented as a planar transmission line, or as a plurality of strip transmission lines running in parallel. **FIG. 2F** depicts an example of a catalytic structure that comprises a plurality of strip transmission lines 272 that can run in parallel along a substrate 222. The assembly can extend through the heater 110. The substrate could be a metal substrate (*e.g.*, copper) which can provide a ground plane and thermal coupling to a heat-transfer substance flowing through the heater 110. The heat-transfer substance may or may not contact a back surface 225 of the substrate. The strip transmission lines 272 can be patterned on the substrate using planar fabrication processes (*e.g.*, depositing the electrically-insulating layer 230, depositing the reactive layer 240, patterning and etching the strip transmission lines 272). The width of each strip transmission line 272 can be between 0.2 mm and 4 mm. In some implementations, the strip transmission lines 272 can be enclosed by a cover 290 to form a reactant space 250 through which the reactant can flow. The cover 290 may or may not be electrically conductive.

[0083] In some cases, the cover 290 can be a conductive metal (*e.g.*, copper) that electrically connects to a conductive substrate 222 to provide a ground reference all around the strips formed from the reactive layer 240. With a ground reference all around the strips and approximately equal distances from the strips, the skin effect (indicated by the dashed lines) can occur on both sides of the strips. The added skin effect on the upper surfaces of the strips formed from the reactive layer provide a shorter path for reactant atoms to enter into active regions of the reactive layer 240. The conductive cover 290 can also provide thermal coupling to a heat-transfer substance, which may or may not contact the exterior of the conductive cover 290.

[0084] 3. Feed-thru and Support of Catalytic Tubes

[0085] FIG. 3A depicts, in a cross-sectional view, further details of a portion of the heating system of FIG. 1A where the containment tube 117 passes through a feed-thru manifold 114 located at one end of the heater 110. Visible in the drawing are an output heat-transfer port 116 and a reactant output port 115 (located behind one of the containment tubes 117). The cross-section passes centrally through the output heat-transfer port 116, the heater 110, and two of the containment tubes 117. The feed-thru structure supports the containment tubes 117, which each house and support a catalytic tube 170 (not installed in the drawing of FIG. 3A).

[0086] The feed-thru manifold 114 comprises a manifold chamber 310 to contain and distribute the reactant to each containment tube 117. The reactant can enter each containment tube 117 through a hole 312 in the sidewall of the containment tube within the manifold chamber 310. The reactant can then travel along a sheath or reactant space 250 (FIG. 2C) between an inner wall of the containment tube 117 and the reactive layer 240 on the outer surface of the catalytic tube 170 (which is installed within the containment tube 117 when the system is operating). The reactant gas or liquid can exit a similar hole 312 in the sidewall of the containment tube 117 within the second feed-thru manifold 114 at an opposite end of the heater 110 (not shown in FIG. 3A).

[0087] Though the manifolds 114 and support structure for the containment tubes 117 are integrated together and attached to the end of the heater 110 in the example heater, the gas manifold structure could be located elsewhere outside the heater. For example, a gas manifold could be mounted apart from the heater and individual gas lines can run from the manifold to each containment tube 117. In such implementations, the support structure for the containment tubes 117 could be located on end walls of the heater chamber 360.

[0088] For the example implementation of FIG. 3A, the containment tubes 117 pass through and are sealed to end walls 320a, 320b of the heater 110 and the feed-thru manifold 114, respectively so that the manifold chamber 310 is airtight. The end wall 320a of the heater 110 can be part of the outer shell 119 for the heater 110. Sealing of the containment tubes 117 to the end walls 320a, 320b can be done using high temperature adhesives, solder, brazing, welding, Teflon® or silicone O-rings, or some combination thereof, for example. The containment tubes 117 can be formed from stainless steel, for example. Other materials

that can be used to form the containment tubes include aluminum, copper, bronze, brass, metal alloys comprising one or more of the preceding materials, galvanized steel, steel coated to resist corrosion.

[0089] The feed-thru manifold 114 can be formed, according to some implementations, by attaching a cup-shaped end-piece 350 to an end of the outer shell 119. The attachment of the end-piece 350 can be done by fasteners (along with a gasket or O-ring) or by an adhesive, solder, brazing, or welding, for example. Prior to attaching the end-piece 350, the containment tubes 117 can be installed in the heater 110 and sealed to the end walls 320a of the heater. The material used to make the feed-thru manifold 114 and the outer shell 119 can comprise stainless steel and/or other materials such as aluminum, copper, bronze, brass, metal alloys comprising one or more of the preceding materials, galvanized steel, steel coated to resist corrosion.

[0090] According to some implementations, the containment tube 117 comprises a tubular portion 317 and an insert 373. A portion of the insert 373 fits within the tubular portion (located inside the manifold chamber 310 in the example implementation). The fit of the insert 373 can be a press fit or friction fit to aid in sealing the two pieces together. In some cases, the insert 373 can be soldered, brazed, or welded to the tubular portion 317. Since the joint between the insert 373 and tubular portion can be located within the manifold chamber 310, a leak at the joint would not affect system operation appreciably. During assembly of the feed-thru manifold 114, the tubular portion 317 can be installed in the heater chamber 360 and sealed to end walls 320a of the heater 110 to prevent influx of heat-transfer substance in the heater chamber 360 into the containment tube 117. The inserts 373 can then be installed in the tubular portions 317 and the end-piece 350 attached. The inserts 373 can then be sealed to the end wall 320b of the feed-thru manifold 114.

[0091] The inserts 373 can be threaded at one end, similar to a Swagelok® fitting. A nut 370 can thread onto the insert 373 and engage (press on) a ferule 375 when tightened onto the insert 373. The ferule 375 can close inward, grabbing and supporting the catalytic tube 170 within the containment tube 117. The nut 370 and ferule 375 can facilitate installation and replacement of the catalytic tube 170. **FIG. 3B** illustrates an expanded cross-sectional view of the insert 373 inserted into one end of the tubular portion 317 of the containment tube 117, together with the nut 370 and the ferule 375.

[0092] In some cases, the ferule 375 can seal the gas chamber formed as an annular reactant space 250 (**FIG. 2A**) between the catalytic tube 170 (when installed within the containment tube) and the containment tube 117. In other cases, an O-ring can be installed between the catalytic tube 170 and containment tube 117 at each end of the catalytic tube 170 to form a sealed gas chamber comprising an annular reactant space 250 around the catalytic tube 170. In some implementations, an insulating sleeve (not shown) can be placed over the catalytic tube 170, so that the sleeve is located between the catalytic tube 170 and the ferule 375. The insulating sleeve can provide electrical isolation of the reactive layer 240 from the containment tube 117 and also assist in forming a gas-tight seal at the ends of the containment tube 117. In some cases, the ferule 375 can be formed from an electrically insulating material (such as Teflon® or silicone rubber) to electrically isolate the catalytic tube 170 and its transmission line 270 from other metals in the heater 110. Because the ferule 375 can be formed from a polymer, it can grip the catalytic tube 170 without deforming the tube to facilitate removal and replacement of the catalytic tube 170.

[0093] According to some implementations, the nuts 370 at the ends of the heater 110 can be cooled by an external cooling loop to reduce degradation of the ferules 375 that are engaged by the nuts 370. **FIG. 3C** depicts an example of a cooling plate 380 that can cool components at the ends of the catalytic tubes when inserted into the containment tubes 117 of **FIG. 3A** and during operation of the heater 110. The cooling plate 380 can be of any shape and be formed from a high-thermal-conductivity material such as copper, an alloy of copper, aluminum, an alloy of aluminum, or a ceramic. The cooling plate 380 can include one or more recesses or openings 384 formed in the cooling plate 380. The recesses or openings 384 can be sized and located to fit over the nuts 370 at the ends of the catalytic tubes 170. In some implementations, the nuts 370 can be cylindrical in shape so that the recesses or openings 384 can be cylindrical. A thermally conductive material (*e.g.*, a thermal grease or gel, indium foil, *etc.*) can be installed between the cooling plate 380 and the nuts 370 to improve the flow of heat from the nuts 370 to the cooling plate 380. The cooling plate 380 can further comprise one or more channels 386 formed within the cooling plate to convey coolant liquid through the plate and in close proximity (*e.g.*, within 5 mm) to the recesses or openings 384. The channels 386 can be formed by milling partial channels into halves of the cooling plate 380 and bonding the halves together or by drilling holes into the cooling plate and sealing some ends of the holes. The cooling plate 380 can further comprise ports 382

fluidically coupled to the channels 386 for connecting the cooling plate 380 to a fluid circuit that carries coolant liquid to and from the cooling plate 380.

[0094] With reference again to **FIG. 3A**, the heater 110 further comprises a heater chamber 360 through which a heat-transfer liquid or gas can flow. The heat-transfer substance comes into contact with the containment tubes 117 which receive heat from catalytic tubes 170 (not shown in **FIG. 3A**) that are installed within the containment tubes 117 when the system is operating. The heater chamber 360 can include a plurality of baffles 363 located throughout the heater chamber 360 to aid in mixing the heat-transfer liquid or gas as it flows through the heater chamber 360. The heat-transfer liquid or gas enters the heater chamber 360 through the one or more input heat-transfer ports 112 and flows out the one or more output heat-transfer ports 116. The inner diameter D of the heater chamber can be between approximately or exactly 10 cm and approximately or exactly 80 cm, though larger diameters are possible to scale heat production. With larger diameters, more containment tubes 117 and catalytic tubes 170 can be installed in the heater 110, increasing its thermal output.

[0095] 4. Electrical Connections to the Catalytic Tubes

[0096] **FIG. 4A** depicts details of an electrical connector 400 that can attach near an end of the catalytic tube 170 of **FIG. 2A** when the tube is installed in the heater 110 of **FIG. 1A**. The illustration is a cross-section taken through the catalytic tube 170 and electrical connector 400. The electrical connector 400 is used to make electrical connections to the electrically-conductive layer 220 and the reactive layer 240 which form the transmission line 270 along the catalytic tube 170. The electrical connector 400 comprises a clamp 405 and a coupling PCB 180a (or coupling PCB 180b) retained within the clamp 405. The electrical connector 400 is one example of apparatus that can be used to make the electrical connections to the transmission line 270. Other structures of apparatus to make the electrical connections to the transmission line 270 are also possible.

[0097] The clamp 405 comprises at least two clamping plates located on opposite sides of the coupling PCB 180. A first clamping plate 410 can be located on a first side of the coupling PCB 180 and can be configured to press on a first collet 415 when drawn toward a second clamping plate 420. The second clamping plate 420 can be located on a second, opposing side of the coupling PCB 180 and be configured to press on a second collet 425 when the second clamping plate 420 is drawn toward the first clamping plate 410. The clamp

405 can further comprise a backing plate 430, which may or may not be electrically conducting. The backing plate 430 can have threaded holes 462 to engage the screws 460 and draw the first clamping plate 410, PCB 180, and second clamping plate 420 toward the backing plate. The first clamping plate 410 and the second clamping plate 420 can be formed from a non-conducting material, such as a polymer.

[0098] The coupling PCB 180 can include at least one transmission line 185, depicted in **FIG. 4B**, to carry electrical excitation pulses provided by the pulse driver 150. The transmission line 185 can comprise two conductive traces running parallel to each other and separated by an insulating layer of the coupling PCB 180 (stacked one above the other in the plan view of **FIG. 4B**). The conductive traces of the transmission line 185 can connect to annular contacts 188 located on opposing surfaces of the coupling PCB 180 (also stacked one above the other in the drawing). However, contacts of shapes other than those shown in **FIG. 4B** can be used; in one example, respective annular contacts for corresponding conductors of the transmission line may be concentric with different diameters rather than stacked one above the other as shown in **FIG. 4B**. The annular contacts 188, or contacts of other shapes, can be located on the coupling PCB 180 for making electrical connections to the first collet 415 and the second collet 425.

[0099] Electrical connection between a first conductive trace of the transmission line 185 on a first side 182 of the coupling PCB 180 and the electrically-conductive layer 220 of the catalytic tube can be made with the first collet 415 and a first conductive sleeve 452. The first conductive sleeve 452 can be placed onto the catalytic tube 170 at a location where the electrically-conductive layer 220 is exposed (along length L_1 , see **FIG. 2A**) and soldered or otherwise electrically connected to the electrically-conductive layer 220. The first conductive sleeve 452 can comprise a highly conductive metal such as copper, aluminum, gold, or an alloy or combination thereof. The first collet 415 can be placed over the first conductive sleeve 452. When the clamp 405 is tightened (by tightening screws 460, for example), drawing the first clamping plate 410 toward the second clamping plate 420, an end face 417 of the first collet 415 engages with a contact (e.g., annular contact 188) on the coupling PCB 180 making an electrical connection between the first conductive trace of the transmission line 185 and the first collet 415. The contact on the PCB can be annular in shape as shown in **FIG. 4B** or can be semi-annular in shape extending at least part way around the catalytic tube 170, for example. In some implementations, an area of the contact on the coupling PCB 180

is the same size as the end face 417 of the first collet 415 that comes into contact with the contact pad or electrical trace.

[0100] When the clamp 405 is tightened further, the first non-conducting clamping plate 410 squeezes the first collet 415 due to a mating conical hole 413 in the clamping plate 410. The conical hole 413 presses on the conical outer wall of the first collet 415 and tightens the first collet 415 onto the first conductive sleeve 452, making electrical connections between the first collet 415, the first conductive sleeve 452, and the electrically-conductive layer 220 on the catalytic tube 170. The taper angle α of the collet outer walls and mating conical holes in the electrical connector 400 can be between 5 degrees and 45 degrees, as measured between a line running along the outer angled wall of the collet (in the z direction) and a line running in the z direction along the inner wall of the collet (roughly indicated above the drawing of the electrical connector 400).

[0101] A similar assembly can be used to make electrical connection between a second conductive trace of the transmission line 185 on a second side 184 of the coupling PCB 180 and the reactive layer 240 on the catalytic tube 170 with the second clamping plate 420 and second collet 425. Tightening the screws 460 also pushes an end face 427 of the second collet 425 into electrical contact with the second trace on the second side 184 of the coupling PCB 180 and tightens the second collet 425 onto a second conductive sleeve 454 placed over the reactive layer 240.

[0102] With reference again to **FIG. 4A** (and as also shown in **FIG. 6A** and **FIG. 6B**, discussed further below), it may be appreciated that the electrical connector 400 is configured and arranged so as to couple the PCB transmission line 185 to the transmission line 270 extending along the catalytic tube such that a first axis defining propagation of a signal along the PCB transmission line is not co-planar with (or parallel to) a second axis defining propagation of the signal along the transmission line extending along the catalytic tube. In particular, in the depicted non-limiting examples, the electrical connector 400 is configured and arranged to couple the PCB transmission line 185 to the transmission line 270 extending along the catalytic tube such that the respective transmission lines are orthogonal or essentially orthogonal to one another.

[0103] The electrical connections via the collets and conductive sleeves to the ends of the transmission line 270 of the catalytic tube 170 can be very low impedance (*e.g.*, from 0.001

mohm to 2 mohms) and the pair may be designed to match the RF impedance of the transmission line 270 of the catalytic tube 170, which can have a value in a range from 0.1 ohm to 75 ohms or from 0.1 ohm to 25 ohms in some cases. In one example implementation, the transmission line 270 has a characteristic impedance of approximately or equal to 10 ohms, more preferably approximately or equal to 5 ohms, and more preferably approximately or equal to 2 ohms. Additionally, transmission lines formed on the coupling PCB 180 can be designed to have an impedance that matches the impedance of the transmission line 270 of the catalytic tube 170. In this manner, catalytic tubes 170 can be electrically connected in series with matched impedances. As such, power reflections to the pulse driver 150 are reduced to levels that can be tolerated by electrical components in the pulse driver 150 and power coupling into the catalytic tubes 170 is increased. Further, fidelity and frequency content of the electrical excitation pulses can be maintained. A matched terminating impedance can be located at an end of the total electrical path after one or more connected catalytic tubes 170 to further prevent power reflections and pulse distortion.

[0104] According to some implementations, the first collet 415 is identical to the second collet 425 in size, shape, and dimensions. This can be possible even though the outer diameter of the catalytic tube 170 can be appreciably different where the two collets are located (see **FIG. 2A**). The first conductive sleeve 452 and the second conductive sleeve 454 can accommodate the differences in diameters. For example, both conductive sleeves can have the same outer diameter that fits within the two collets. The inner diameter of the first conductive sleeve 452 can be smaller than the inner diameter of the second conductive sleeve 454 to accommodate the differences in diameters of the catalytic tube 170 where the exposed electrically-conductive layer 220 is located along length L_1 and the exposed reactive layer 240 is located along length L_2 . In some implementations, the first collet 415, the second collet 425, the first conductive sleeve 452, and the second conductive sleeve 454 can be plated with a high conductor, such as gold or copper, to reduce contact resistance and provide better impedance matching. Further, the exposed portions of the electrically-conductive layer 220 and the reactive layer 240 can be plated with a high conductor, such as gold or copper.

[0105] The backing plate 430 can include one or more resilient contact elements for applying a resilient force against the second clamping plate 420. A resilient contact element can comprise at least one spring, at least one flexural tab, at least one wave washer, at least one piece of compliant material, *etc.* In the illustration of **FIG. 4A**, the resilient contact element

comprises a wave washer 435 that can resiliently press against the second clamping plate 420 at three or more contact points. The resilient contact element can allow for expansion and contraction of the length and diameter of the catalytic tube 170 due to changes in operating temperatures while maintaining sufficient and nearly constant pressure on the first collet 415 and the second collet 425 to preserve the integrity of electrical connections to the electrically-conductive layer 220 and the reactive layer 240.

[0106] The clamp 405 may or may not include counter springs 440, which can be located anywhere between the first clamping plate 410 and PCB 180 and/or between the second clamping plate 420 and PCB 180. The counter springs 440 are arranged to push apart the first clamping plate 410 and the second clamping plate 420 away from the PCB 180 when screws 460 are loosened. The counter springs 440 can facilitate removal of the electrical connector 400 from the catalytic tube 170 (*e.g.*, for replacement of the catalytic tube).

[0107] Although FIG. 4A illustrates only one electrical connector 400 for one catalytic tube 170, other configurations are possible. In some cases, the coupling PCB 180 can be large enough to extend across the ends of two or more catalytic tubes mounted in a heater 110. Transmission lines formed on the coupling PCB 180 can make electrical connections between different catalytic tubes 170. For example, the coupling PCB 180 can have transmission lines 154 (FIG. 1A) formed thereon to convey excitation pulses from the pulse driver 150 and from catalytic tube to catalytic tube. The PCB can connect catalytic tubes 170 in serial or in parallel. Parallel connections may require higher current output from the pulse driver 150 whereas serial connections may require higher voltage output from the current driver compared to a single catalytic tube. In some implementations, the first clamping plate 410, second clamping plate 420, and backing plate 430 can also extend across the ends of two or more catalytic tubes mounted in a heater 110. Extending the clamping plates and backing plate can reduce piece count, expedite assembly, and allow for a tighter packing of containment tubes 117 and catalytic tubes 170 in a heater at the cost of tighter alignment tolerances for distances between catalytic tube tubes. Having separate clamping plates and backing plates for each catalytic tube or subgroups of tubes may provide higher assurance of adequate electrical connections to the electrically-conductive layer 220 and the reactive layer 240 on each catalytic tube 170.

[0108] FIG. 4C illustrates, in a cross-sectional view, further details of the first collet 415 and the second collet 425 that are used to make electrical connections between transmission lines

185 on the coupling PCB 180 and the transmission line 270 of the catalytic tube 170 with the electrical connector 400 of **FIG. 4A**. **FIG. 4D** is a cross-section, perspective view of the second collet 425, which can be identical to the first collet 415, though different collets can be used in some cases. The first collet 415 and the second collet 425 each comprise longitudinal cuts 422 extending part way along the length of each collet. The longitudinal cuts 422 allow each collet to flex and its inner diameter to reduce when the conical outer wall of each collet is pressed on by the mating conical holes 413 in the first clamping plate 410 and the second clamping plate 420.

[0109] **FIG. 4E** depicts an end of a catalytic tube 170 that can be inserted into the electrical connector 400 of **FIG. 4A**. The first conductive sleeve 452 and the second conductive sleeve 454 are placed over exposed regions of the electrically-conductive layer 220 and the reactive layer 240, respectively, on each catalytic tube 170. In some implementations, the second conductive sleeve 454 can include a flange 457 at one end to act as a stop for the second collet 425 when installing the clamping plates 410, 420 and coupling PCB 180.

[0110] In some implementations, one of the first collet 415 and second collet 425 may or may not include cuts for flexural purposes, may not have a conical shape, and a conductive sleeve may not be used. Instead, the first collet or second collet can have an end face 417 or 427 and be placed over and clamped to the exposed conductive layer. The collet may have one through-cut to allow expansion and compression of the collet ring, or the collet may be formed as two half pieces that can be clamped to either side of the catalytic tube 170. In some cases, the collet may be formed as multiple pieces that clamp to the catalytic tube 170. For easier implementation, the collet closer to the center of the catalytic tube (the second collet 425 in **FIG. 4A**) can be clamped to the tube. The electrical connector 400 can then include one clamping plate that only grasps the clamped collet and, for example, the first clamping plate 410 and first collet 415 as shown in **FIG. 4A**. When the first clamping plate 410 is drawn toward the clamping plate that grasps the clamped collet, the first clamping plate 410 will engage the first collet and draw it and the PCB 180 toward the clamped collet establishing electrical contact between the two collets and their respective annular contacts 188 on the PCB 180.

[0111] 5. Additional Heater Implementations

[0112] FIG. 5 depicts another implementation of a heater 510 that can be used in the heating system of FIG. 1A. The illustration is a cross-section that passes through the containment tube 117. Electrical connections to the catalytic tube 170 are not shown to simplify the drawing. The heater 510 shows only one containment tube 117 and catalytic tube 170 within the heater, but more containment tubes and catalytic tubes can be mounted within such a heater.

[0113] The heater 510 can be supplied with a reactant through a reactant input line 144 and supplied with a heat-transfer liquid or gas through a heat-transfer line 164. The reactant and heat-transfer gas or liquid can exit through a reactant output port and output heat-transfer port, respectively, at an opposite end of the heater 510. The heater 510 comprises a vacuum chamber 520 surrounding the containment tube 117 and a water jacket 530. Vacuum can be established within the vacuum chamber 520 through vacuum port 522. The vacuum chamber 520 can reduce heat transfer from the catalytic tube 170 to an external environment.

[0114] The heater 510 comprises an outer shell 119 containing a water jacket 530 surrounding the containment tube 117. The water jacket 530 comprises a jacket tube 535 having a larger inner diameter than the outer diameter of the containment tube 117 so that a sheath of heat-transfer fluid or gas can flow in a space between the containment tube 117 (from which heat is extracted) and the jacket tube 535. The jacket tube 535 can be part of the outer shell 119 which forms the vacuum chamber 520. Similar to the heater 110 of FIG. 1B and FIG. 3, the reactant can flow in a sheath along a reactant space 250 between an outer surface of the catalytic tube 170 and an inner surface of the containment tube 117. This reactant space 250 can be sealed at each end of the heater by a seal 552 (such as an O-ring).

[0115] For the heater designs of FIG. 2C and FIG. 5, the reactant space 250 can be packed with a material having high thermal conductivity (*e.g.*, over $10 \text{ W m}^{-1} \text{ K}^{-1}$) and providing electrical isolation within the heater along an active length of the catalytic tube 170 where heat is generated. An example of a material having high thermal conductivity is alumina, which can also provide electrical isolation, though other electrically insulating materials having a high thermal conductivity may be used. To impede thermal conductivity near the ends of the catalytic tube 170, where the seal 552 and electrical connections are located, the reactant space can be packed with an electrically-insulating fill material that has a low thermal conductivity, such as silica, though other materials having a low thermal conductivity may be used.

[0116] 6. Drive Electronics

[0117] FIG. 6A and FIG. 6B depict an example implementation of drive electronics 600 used to transmit excitation pulses down the transmission line 270 of the catalytic tubes 170. The drive electronics 600 can comprise part or all of the pulse driver 150 discussed above in connection with **FIG. 1A** and other figures. In the illustrations, the drive electronics 600 are implemented on multiple printed circuit boards (*e.g.*, the coupling PCB 180a and one or more auxiliary PCBs 620-1, 620-2, 620-3 that electrically couple to the coupling PCB 180a). Implementing at least some of the drive electronics 600 on the coupling PCB 180a can improve the quality of the excitation pulses delivered to the catalytic tube(s) 170. For example, shorter pulse rise times and/or durations may be possible compared to generating the excitation pulses with a remote electronic driver and transmitting the excitation pulses over lengthy transmission lines to the catalytic tube(s) 170.

[0118] In some implementations, the drive electronics 600 are configured to receive pulses from a pulse source (which can be located separately from the drive electronics) and adapt the received pulses for delivery as excitation pulses to the electrical connector 400 and transmission line 270 of the catalytic tube 170. Adaptation of the received pulses can comprise at least one of (1) preparing the excitation pulses to have a selected voltage amplitude, (2) providing sufficient current for each excitation pulse, (3) preparing the excitation pulses to have a selected pulse shape, and providing the excitation pulses over a transmission line that is impedance matched to the electrical connector 400 and transmission line 270.

[0119] In some implementations, the pulses received by the drive electronics 600 can be optical pulses. The optical pulses can be converted to electrical excitation pulses by the drive electronics 600 (with an opto-isolator, for example). Using such optical isolation can protect the pulse source from electromagnetic interference generated by the drive electronics 600 when outputting excitation pulses to the catalytic tube(s) 170.

[0120] The drive electronics 600 can comprise high-power, high-speed transistors 630 (such as gallium-nitride transistors) to perform voltage switching at moderate voltages (*e.g.*, up to 100 volts) with high currents for generation of the excitation pulses. The transistors 630 (visible in **FIG. 6B**) can be mounted on the coupling PCB 180a in close proximity (*e.g.*, within about 10 cm) to the location where the electrical connector 400 contacts the coupling

PCB 180a. These transistors can generate significant heat during operation of the system. A heat sink 610 can be thermally coupled to the transistors 630 to aid in dissipating the heat generated by the transistors. The heat sink 610 can have a channel within it to flow a coolant through the heat sink. The coolant can be circulated through the heat sink with coolant lines 612. There can be a back plate 611 mounted to an opposite side of the coupling PCB 180a (visible in **FIG. 6B**) for additional cooling and to aid in connecting and thermally coupling the heat sink 610 to the coupling PCB 180a. The heat sink 610 and the back plate 611 can be made from a material having high thermal conductivity, such as copper or aluminum.

[0121] The opposite end of the catalytic tube 170 from the near end shown in **FIG. 6A** can connect to a different coupling PCB 180b (**FIG. 1A**) which may not include drive electronics 600. The coupling PCB 180b can include transmission lines to couple the distal end of a first catalytic tube 170 to the distal end of a second catalytic tube 170 at the same end of the heater 110. The coupling PCB 180b can also include probe points and may further include sensing electronics for detecting excitation pulses which have passed through a catalytic tube 170 (*e.g.*, to check excitation pulse quality and evaluate tube performance). Output from the sensing electronics can be provided to the system controller 190 to monitor operation of the system. The system controller 190 can output a signal or shut down the system if the system controller 190 determines that system service is needed (*e.g.*, detection of a faulty catalytic tube 170).

[0122] Each of the coupling PCBs 180a, 180b can include transmission lines patterned on the PCB to carry pulses to and from the transmission lines formed on the catalytic tubes 170. The transmission lines patterned on the coupling PCBs 180a, 180b can be engineered to have RF impedance values that match the RF impedance values of the transmission lines formed on the catalytic tubes 170. For example, the RF impedance values of the transmission lines patterned on the coupling PCBs 180a, 180b be within 10% of the RF impedance values of the transmission lines formed on the catalytic tubes 170 over a range of frequencies from approximately or exactly 250 MHz to 2 GHz, impedance matching over other frequency ranges is possible.

[0123] 7. Catalytic Tube Fabrication Process

[0124] Steps for an example method 700 of fabricating a catalytic tube 170 are illustrated in the flow chart of **FIG. 7**. The flow chart does not necessarily include all the steps performed

in the fabrication process. There can be additional inspection and cleaning steps not included in the flow chart, for example.

[0125] An example fabrication process can begin with obtaining, inspecting, cleaning (act 705), or otherwise preparing the support 210 that will be used to make a catalytic tube 170. The support 210 can be cleaned (act 705) in any suitable manner to remove surface contaminants and manufacturing oil residues, for example. A cleaning process can include applying a cleaning fluid, agitation, and rinsing of at least the outer surface of the support 210. The cleaning fluid can be a soap and/or chemical solvent (such as acetone or methanol), which may be applied in separate steps. The agitation can comprise ultrasonic agitation or a scrubbing process (*e.g.*, using a mechanical brushing or wiping of the surface(s) of the support 210. The rinsing process can comprise applying a rinse fluid to the surface(s) of the support 210. The rinsing process can include applying one or more mild solvents (ethanol, deionized water) to wash the surface(s) of the support 210. The application can be by a mechanical spray. Some or all sub-steps of cleaning (act 705) can be automated with robotic mechanical apparatus that is controlled by at least one controller.

[0126] After cleaning, a first conductive sub-layer of the electrically-conductive layer 220 can be deposited (act 710) on the support 210. The deposition of the first conductive sub-layer can comprise a plasma spray deposition of material (*e.g.*, copper and/or another conductor) used to form the first sub-layer. Forming the electrically-conductive layer 220 by using, in part, a plasma spray deposition process can be beneficial because the deposited first conductive sub-layer can have a semi-porous and sponge-like morphology. The semi-porous morphology can provide some elastic compressibility and/or improved stress and strain capacity of the deposited layer that can help accommodate differences in CTEs of the layers deposited on the support 210 and difference in CTE of the support. For example, during operation of the heater 110, the temperature of the catalytic tubes 170 may increase to as much as 800 °C or higher. As the temperature increases, the support 210 can expand in diameter and length whereas the electrically-insulating layer 230 may expand less, putting compressive radial stress and shear stress on the electrically-conductive layer 220. The semi-porous morphology of the first conductive sub-layer of the electrically-conductive layer 220 can help absorb the radial and shear stresses to help avoid heat-induced damage to the catalytic tube 170.

[0127] The first conductive sub-layer can be annealed (act 715) following its deposition to improve adhesion to the underlying support 210 and/or to improve conductivity of the first conductive sub-layer. The annealing may also smooth the outer surface of the first conductive sub-layer to improve high-frequency transmission of the electronic excitation pulses from the pulse driver 150. The anneal temperature can be in a range from approximately or exactly 200 °C to approximately or exactly 800 °C and the duration of the anneal can be from approximately or exactly 20 minutes to approximately or exactly 120 minutes. The anneal time and temperature can depend on the granularity and composition of the material being annealed.

[0128] In some implementations, at least one thin adhesion layer (*e.g.*, titanium, chrome, nickel, niobium, tungsten, another material, or some combination thereof) can be deposited on the support 210 before depositing the first conductive sub-layer to improve adhesion of the first conductive sub-layer to the support 210. In some cases, there can be two, three, or more adhesion layers of at least two different materials between the support 210 and the electrically-conductive layer 220. The thickness of each adhesion layer can be from approximately or exactly 5 nm to approximately or exactly 500 nm, though thinner or thicker adhesion layers can be used.

[0129] A second conductive sub-layer can be electrically plated (act 720) onto the first conductive sub-layer and subsequently annealed (act 725). The second conductive sub-layer can be formed from the same material as the first conductive sub-layer or from a different material. The plating can provide a surface morphology of the electrically-conductive layer 220 that is smoother, more dense, and has a higher electrical conductivity than the underlying material deposited by plasma spray deposition. The smoother morphology and higher conductivity can be beneficial for transmission of the excitation pulses (*e.g.*, improve transmission speed or velocity of the transmission line).

[0130] The subsequent anneal (act 725) can improve adhesion of the second conductive sub-layer to the first conductive sub-layer and remove the stress in the plated material's surface for improved layer mechanical integrity. The first conductive sub-layer and the second conductive sub-layer form at least part of the electrically-conductive layer 220.

[0131] Next, an insulator for the electrically-insulating layer 230 can be deposited (act 730) over the electrically-conductive layer 220. In one example, alumina particles (preferably

nanoparticles) are deposited onto the electrically-conductive layer 220. The deposition of the particles can be by plasma spray deposition. According to some implementations, micron-scale particles are introduced into the plasma spray head, which heats the particles rapidly to temperatures in a range from 3000 °C to 6000 °C. Upon rapid heating, the micron-scale particles explode into nanoparticles that deposit onto the electrically-conductive layer 220.

[0132] Generally, deposition of smaller particles of insulator are preferred when forming the electrically-insulating layer 230. The smaller particles can form a more dense and less porous electrically-insulating layer 230 which can improve its acoustic properties. The inventors have recognized and appreciated that a porous morphology of the electrically-insulating layer 230 can significantly reduce power efficiency of the heating system 100. The inventors postulate that phonons produced by the excitation pulses and which participate in heat production in the electrically-conductive, reactive layer 240 are undesirably absorbed by a porous electrically-insulating layer 230. A highly dense insulating layer 230 can more efficiently reflect the phonons back into the electrically-conductive, reactive layer 240, increasing heat generation and improving the reactivity of the reactive layer 240.

[0133] After deposition of the insulator, the outer surface of the deposited layer can be smoothed (act 735) by a polishing, grinding, filing, sanding, or other process. Diamond cutting, filing, and/or polishing apparatus can be used for smoothing the outer surface. The smoothing step may also reduce the diameter of the intermediate catalytic tube assembly to a desired or target diameter.

[0134] An electrically-insulating glaze can then be applied (act 740) to the surface of the insulator and fired (act 745) to densify and smooth the outer surface of the electrically-insulating layer 230. In some implementations, a liquid, spin-on glass is applied to the outer surface and solidified into a borosilicate glass by the firing (act 745) or a high-temperature bake (*e.g.*, at a temperature from approximately or exactly 700 °C to approximately or exactly °950 C), though other bake temperatures are possible for some applications. The liquid glass can be applied by a spray-on process, dipping, brush-on process, or other process. The liquid glass can include dopants, examples of which are available from Desert Silicon of Pheonix, Arizona. The thickness of the solidified glaze can be from approximately or exactly 500 nm to approximately or exactly 60 microns, though thicker glazes can be used in some cases. The insulator and fired glaze can form at least part of the electrically-insulating layer 230. The smoothed outer surface can provide a smooth base on which to deposit the

electrically-conductive, reactive layer 240 such that the inner surface of the electrically-conductive, reactive layer 240 will be smooth for high-frequency propagation of the excitation pulses from the pulse driver 150.

[0135] In some implementations, the glaze can be formed using a different process, such as plasma spray deposition of silica glass. The silica glass can be deposited to a thickness between approximately or exactly 500 nm to approximately or exactly 60 microns.

[0136] A third conductive sub-layer can be deposited (act 750) on the outer surface of the electrically-insulating layer 230. The third conductive sub-layer may or may not be annealed after its deposition. The material used for the third conductive sub-layer can have high conductivity for low-loss and high-frequency propagation of the excitation pulses. Examples of such material include copper, aluminum, gold, silver, or some alloy thereof. The third conductive sub-layer can be applied in the same manner as the first conductive sub-layer described above. In some implementations, an adhesion layer (*e.g.*, titanium, chrome, niobium, tungsten, another material, or some combination thereof) can be deposited on the electrically-insulating layer 230 prior to deposition of the third conductive sub-layer to improve adhesion of the third conductive sub-layer to the electrically-insulating layer 230.

[0137] A reactive material (*e.g.*, nickel, palladium, other reactive material disclosed above, or some combination thereof) can then be deposited (act 755) onto the third conductive sub-layer to complete formation of the electrically-conductive, reactive layer 240. In some implementations, the reactive material (*e.g.*, nickel) is deposited by a plasma-spray deposition process. In other implementations, the reactive material may be deposited using a wire arc additive manufacturing process, in which the reactive material is supplied in a wire that is heated and vaporized through an arc discharge.

[0138] After deposition of the electrically-conductive, reactive layer 240, electrical tests can then be performed (act 760) on the catalytic tube to verify its quality before or after attaching (act 765) the conductive sleeves 452, 454 to the ends of the catalytic tube 170.

[0139] 8. Conclusion

[0140] While various inventive embodiments have been described and illustrated herein, those of ordinary skill in the art will readily envision a variety of other means and/or structures for performing the function and/or obtaining the results and/or one or more of the advantages described herein, and each of such variations and/or modifications is deemed to

be within the scope of the inventive embodiments described herein. More generally, those skilled in the art will readily appreciate that all parameters, dimensions, materials, and configurations described herein are meant to be exemplary and that the actual parameters, dimensions, materials, and/or configurations will depend upon the specific application or applications for which the inventive teachings is/are used. Those skilled in the art will recognize or be able to ascertain, using no more than routine experimentation, many equivalents to the specific inventive embodiments described herein. It is, therefore, to be understood that the foregoing embodiments are presented by way of example only and that inventive embodiments may be practiced otherwise than as specifically described. Inventive embodiments of the present disclosure are directed to each individual feature, system, article, material, kit, and/or method described herein. In addition, any combination of two or more such features, systems, articles, materials, kits, and/or methods, if such features, systems, articles, materials, kits, and/or methods are not mutually inconsistent, is included within the inventive scope of the present disclosure.

[0141] Also, various inventive concepts may be embodied as one or more methods, of which an example has been provided. The acts performed as part of the method may be ordered in any suitable way. Accordingly, embodiments may be constructed in which acts are performed in an order different than illustrated, which may include performing some acts simultaneously, even though shown as sequential acts in illustrative embodiments.

[0142] All definitions, as defined and used herein, should be understood to control over dictionary definitions, definitions in documents incorporated by reference, and/or ordinary meanings of the defined terms.

[0143] Unless stated otherwise, the terms “approximately” and “about” are used to mean within $\pm 20\%$ of a target (*e.g.*, dimension or orientation) in some embodiments, within $\pm 10\%$ of a target in some embodiments, within $\pm 5\%$ of a target in some embodiments, and yet within $\pm 2\%$ of a target in some embodiments. The terms “approximately” and “about” can include the target. The term “essentially” is used to mean within $\pm 3\%$ of a target.

[0144] The indefinite articles “a” and “an,” as used herein, unless clearly indicated to the contrary, should be understood to mean “at least one.”

[0145] The phrase “and/or,” as used herein, should be understood to mean “either or both” of the elements so conjoined, *i.e.*, elements that are conjunctively present in some cases and

disjunctively present in other cases. Multiple elements listed with “and/or” should be construed in the same fashion, i.e., “one or more” of the elements so conjoined. Other elements may optionally be present other than the elements specifically identified by the “and/or” clause, whether related or unrelated to those elements specifically identified. Thus, as a non-limiting example, a reference to “A and/or B”, when used in conjunction with open-ended language such as “comprising” can refer, in one embodiment, to A only (optionally including elements other than B); in another embodiment, to B only (optionally including elements other than A); in yet another embodiment, to both A and B (optionally including other elements); etc.

[0146] As used herein, “or” should be understood to have the same meaning as “and/or” as defined above. For example, when separating items in a list, “or” or “and/or” shall be interpreted as being inclusive, i.e., the inclusion of at least one, but also including more than one, of a number or list of elements, and, optionally, additional unlisted items. Only terms clearly indicated to the contrary, such as “only one of” or “exactly one of” or “consisting of,” will refer to the inclusion of exactly one element of a number or list of elements. In general, the term “or” as used herein shall only be interpreted as indicating exclusive alternatives (i.e., “one or the other but not both”) when preceded by terms of exclusivity, such as “either,” “one of,” “only one of,” or “exactly one of.” “Consisting essentially of,” shall have its ordinary meaning as used in the field of patent law.

[0147] As used herein, the phrase “at least one,” in reference to a list of one or more elements, should be understood to mean at least one element selected from any one or more of the elements in the list of elements, but not necessarily including at least one of each and every element specifically listed within the list of elements and not excluding any combinations of elements in the list of elements. This definition also allows that elements may optionally be present other than the elements specifically identified within the list of elements to which the phrase “at least one” refers, whether related or unrelated to those elements specifically identified. Thus, as a non-limiting example, “at least one of A and B” (or, equivalently, “at least one of A or B,” or, equivalently “at least one of A and/or B”) can refer, in one embodiment, to at least one, optionally including more than one, A, with no B present (and optionally including elements other than B); in another embodiment, to at least one, optionally including more than one, B, with no A present (and optionally including elements other than A); in yet another embodiment, to at least one, optionally including more

[0100] than one, A, and at least one, optionally including more than one, B (and optionally including other elements); etc.

[0101] In the specification above, all transitional phrases such as “comprising,” “including,” “carrying,” “having,” “containing,” “involving,” “holding,” “composed of,” and the like are to be understood to be open-ended, i.e., to mean including but not limited to. Only the transitional phrases “consisting of” and “consisting essentially of” shall be closed or semi-closed transitional phrases, respectively, as set forth in the United States Patent Office Manual of Patent Examining Procedures, Section 2111.03.

CLAIMS

1. An electrical connector (400) for electrically connecting to a transmission line (270) that extends along a catalytic tube (170), wherein the catalytic tube comprises an exposed first portion of an electrically-conductive layer (220) disposed on an outer surface of the catalytic tube and an exposed first portion of an electrically-conductive reactive layer (240) disposed on the outer surface of the catalytic tube, the transmission line comprising a second portion of the electrically-conductive layer and a second portion of the electrically-conductive reactive layer, the electrical connector comprising:
 - a first clamping plate (410) having a first conical hole (413) formed through the first clamping plate through which the catalytic tube can pass;
 - a second clamping plate (420) having a second conical hole (413) formed through the second clamping plate through which the catalytic tube can pass;
 - a first collet (415) to place over the exposed first portion of the electrically-conductive layer (220) and locate in the first conical hole; and
 - a second collet (425) to place over the exposed first portion of the electrically-conductive reactive layer (240) and locate in the second conical hole.
2. The electrical connector of claim 1, in combination with the catalytic tube and the transmission line.
3. The combination of claim 2, wherein the catalytic tube is configured to generate heat via a heat-generating reaction based at least in part on electrical pulses coupled via the electrical connector to the transmission line and propagating along the transmission line.
4. The electrical connector of claim 1, further comprising:
 - a first conductive sleeve (452) to place over the exposed first portion of an electrically-conductive layer and to establish electrical connection between the first collet and the exposed first portion of an electrically-conductive layer; and
 - a second conductive sleeve (454) to place over the exposed first portion of an electrically-conductive reactive layer and to establish electrical connection between the second collet and the exposed first portion of an electrically-conductive reactive layer.

5. The electrical connector of claim 1, wherein the first collet is identical in shape and inner diameter to the second collet.
6. The electrical connector of claim 1, wherein:
 - the first collet comprises a first end face (417) and first longitudinal cuts (422) extending part way along a length of the first collet to allow flexure of the first collet; and
 - the first collet, when engaged by the first clamping plate when the first clamping plate is drawn toward the second clamping plate, flexes to reduce an inner diameter of the first collet and thereby establishes a first electrical connection between the first collet and the electrically-conductive layer of the catalytic tube.
7. The electrical connector of claim 6, wherein the first electrical connection between the first collet and the electrically-conductive layer of the catalytic tube has an impedance in a range of from approximately or equal to 0.001 milliohms to approximately or equal to 2 milliohms.
8. The electrical connector of claim 6, wherein:
 - the second collet comprises a second end face (427) and second longitudinal cuts extending part way along a length of the second collet to allow flexure of the second collet; and
 - the second collet, when engaged by the second clamping plate when the second clamping plate is drawn toward the first clamping plate, flexes to reduce an inner diameter of the second collet and thereby establish a second electrical connection between the second collet and the electrically-conductive reactive layer of the catalytic tube.
9. The electrical connector of claim 8, wherein each of the first electrical connection between the first collet and the electrically-conductive layer of the catalytic tube and the second electrical connection between the second collet and the electrically-conductive reactive layer has an impedance in a range of from approximately or equal to 0.001 milliohms to approximately or equal to 2 milliohms.
10. The electrical connector of claim 9, wherein the electrical connector has an RF characteristic impedance in a range of from approximately or equal to 0.1 ohms to approximately or equal to 25 ohms.

11. The electrical connector of claim 9, wherein the electrical connector has an RF characteristic impedance in a range of from approximately or equal to 0.1 ohms to approximately or equal to 10 ohms.
12. The electrical connector of claim 9, wherein the electrical connector has an RF characteristic impedance of approximately or equal to 2 ohms.
13. The electrical connector of claim 9, further comprising:
 - a first conductive sleeve (452) to place over the exposed first portion of an electrically-conductive layer and to establish electrical connection between the first collet and the exposed first portion of an electrically-conductive layer; and
 - a second conductive sleeve (454) to place over the exposed first portion of an electrically-conductive reactive layer and to establish electrical connection between the second collet and the exposed first portion of an electrically-conductive, reactive layer.
14. The electrical connector of claim 13, wherein the first conductive sleeve has a same outer diameter as an outer diameter of the second conductive sleeve and has a different inner diameter than an inner diameter of the second conductive sleeve.
15. The electrical connector of claim 1, wherein the electrical connector is configured to:
 - locate a printed circuit board (PCB) (180) between the first clamping plate and the second clamping plate, the PCB having:
 - a first contact (188) located on a first side of the PCB to contact a first end face (417) of the first collet; and
 - a second contact (188) located on a second side of the PCB to contact a second end face (427) of the second collet.
16. The electrical connector of claim 15, in combination with the PCB.
17. The electrical connector of claim 15, wherein the PCB includes a PCB transmission line coupled to the first contact and the second contact, and wherein:
 - the electrical connector is configured to couple the PCB transmission line to the transmission line extending along the catalytic tube such that the PCB transmission line is orthogonal or essentially orthogonal to the transmission line extending along the catalytic tube.

18. The electrical connector of claim 17, in combination with the PCB, the catalytic tube, and the transmission line extending along the catalytic tube.
19. The electrical connector of claim 17, wherein the electrical connector has a first RF characteristic impedance that is within +/- 10% of a second RF characteristic impedance of the PCB transmission line and a third RF characteristic impedance of the transmission line extending along the catalytic tube.
20. The electrical connector of claim 19, wherein the first RF characteristic impedance of the electrical connector is in a range of from approximately or equal to 0.1 ohms to approximately or equal to 25 ohms.
21. The electrical connector of claim 19, wherein the first RF characteristic impedance of the electrical connector is in a range of from approximately or equal to 0.1 ohms to approximately or equal to 10 ohms.
22. The electrical connector of claim 19, wherein the first RF characteristic impedance of the electrical connector is approximately or equal to 2 ohms.
23. The electrical connector of claim 15, wherein the PCB includes a PCB transmission line coupled to the first contact and the second contact, and wherein:
 - the electrical connector has a first RF characteristic impedance that is within +/- 10% of a second RF characteristic impedance of the PCB transmission line and a third RF characteristic impedance of the transmission line extending along the catalytic tube.
24. The electrical connector of claim 23, wherein the first RF characteristic impedance of the electrical connector is in a range of from approximately or equal to 0.1 ohms to approximately or equal to 25 ohms.
25. The electrical connector of claim 23, wherein the first RF characteristic impedance of the electrical connector is in a range of from approximately or equal to 0.1 ohms to approximately or equal to 10 ohms.
26. The electrical connector of claim 23, wherein the first RF characteristic impedance of the electrical connector is approximately or equal to 2 ohms.

27. The electrical connector claim 15, further comprising:
- at least one first spring (440) to locate between the PCB and the first clamping plate to resiliently push the first clamping plate away from the PCB; and
 - at least one second spring (441) to locate between the PCB and the second clamping plate to resiliently push the second clamping plate away from the PCB.
28. The electrical connector of claim 27, further comprising:
- a backing plate (430) to engage screws (460) and draw the first clamping plate toward the second clamping plate; and
 - a resilient contact element (435) to place between the backing plate and the first clamping plate or the second clamping plate to resiliently press against the first clamping plate or the second clamping plate, respectively.
29. A method of establishing electrical connection to a transmission line (270) formed on a catalytic tube (170), the transmission line comprising:
- an electrically-conductive layer (220) disposed on a support of the catalytic tube;
 - an insulating layer (230) disposed on the electrically-conductive layer; and
 - an electrically-conductive reactive layer (240) disposed on the insulating layer,
- wherein the transmission line extends along a length of the catalytic tube,
- the method comprising:
- engaging, with a first clamping plate (410) of a clamp (405), a first collet (415) located over an exposed portion of the electrically-conductive layer to reduce an inner diameter of the first collet and thereby establish a first electrical connection between the first collet and the electrically-conductive layer; and
 - engaging, with a second clamping plate (420) of the clamp (405), a second collet (425) located over an exposed portion of the electrically-conductive reactive layer to reduce an inner diameter of the second collet and thereby establish a second electrical connection between the second collet and the electrically-conductive, reactive layer.
30. The method of claim 29, wherein establishing the first electrical connection comprises contacting a conductive sleeve (452) with the first collet, the conductive sleeve electrically connected to the electrically-conductive layer.

31. The method of claim 30, wherein establishing the second electrical connection comprises contacting a conductive sleeve (454) with the second collet, the conductive sleeve electrically connected to the electrically-conductive, reactive layer.
32. The method of claim 29, wherein the engaging of the first collet and the engaging of the second collet further comprises:
- establishing a first electrical connection between a first end face (417) of the first collet and a first contact (188) on a first side of a PCB (180) located between the first clamping plate and the second clamping plate; and
 - establishing a second electrical connection between a second end face (417) of the second collet and a second contact (188) on a second side of the PCB.
33. The method of claim 32, wherein at least one of the first contact and second contact have an annular shape.
34. The method of claim 29, wherein an impedance of the transmission line of the catalytic tube is a value in a range from 1 ohm to 25 ohms.
35. A method of making a transmission line (270) for a catalytic tube that generates heat for a heater, the method comprising:
- depositing (710) a first conductive sub-layer on a tubular support (210);
 - plating (720) a second conductive sub-layer on the first conductive sub-layer to form an electrically-conductive layer (220) of the transmission line;
 - depositing (730) an insulator over the electrically-conductive layer;
 - depositing (750) a third conductive sub-layer over the insulator; and
 - depositing (755) a reactive material over the third conductive sub-layer to form, at least in part, the transmission line.
36. The method of claim 35, further comprising:
- annealing at least one of the first conductive sub-layer or the second conductive sub-layer.
37. The method of claim 35, further comprising annealing (725) the second conductive sub-layer to smooth an outer surface of the second conductive sub-layer for high-frequency

propagation of excitation pulses along the transmission line.

38. The method of claim 35, wherein the first conductive sub-layer, the second conductive sub-layer, and the third conductive sub-layer each comprise copper.
39. The method of claim 35, wherein the insulator comprises alumina.
40. The method of claim 35, wherein the reactive material comprises nickel.
41. The method of claim 35, further comprising:
 - annealing (715) the first conductive sub-layer to improve adhesion of the first conductive sub-layer to the tubular support.
42. The method of claim 35, further comprising:
 - smoothing (735) a surface of the insulator;
 - applying (740) a glaze to the insulator; and
 - firing (745) the glaze to smooth an outer surface of the insulator.
43. The method of claim 42, wherein smoothing the surface of the insulator comprises reducing a diameter of the catalytic tube to a target diameter.
44. The method of claim 35, further comprising:
 - depositing an adhesion layer over the insulator before depositing the third conductive sub-layer.
45. The method of claim 44, wherein the adhesion layer comprises at least one of titanium, chrome, niobium, or tungsten.
46. A method of heating a fluidic substance with a catalytic tube (170) mounted inside a containment tube (117), each of which extends through a heater chamber (360) of a heater (110), the method comprising:
 - flowing a reactant over an electrically-conductive, reactive layer (240) disposed on an outer surface of the catalytic tube, wherein the reactant flows in a space (250) between the outer surface of the catalytic tube and an inner surface of the containment tube;
 - propagating electrical pulses along a transmission line (270) disposed on the catalytic tube, the transmission line formed in part by the electrically-conductive, reactive layer; and

coupling heat from the containment tube to a heat-transfer liquid or gas flowing within the heater chamber.

47. The method of claim 46, further comprising coupling heat from the catalytic tube to a second heat-transfer liquid or gas flowing within the catalytic tube.

48. The method of claim 46, wherein flowing the reactant comprises flowing a gas containing hydrogen over the electrically-conductive, reactive layer.

49. The method of claim 46, wherein flowing the reactant comprises delivering the reactant to the space from a manifold (114), the manifold further delivering the reactant to a second space between a second outer surface of a second catalytic tube and a second inner surface of a second containment tube, wherein the second catalytic tube and the second containment tube also extend through the heater chamber of the heater.

50. The method of claim 49, wherein:

the manifold is integrated onto an end of the heater; and

the catalytic tube and containment tube further extend through the manifold.

51. The method of claim 46, wherein propagating the electrical pulses along the transmission line comprises:

coupling the electrical pulses from an electrical connector (400) that is connected to an end of the catalytic tube, the electrical connector comprising:

a first clamping plate (410) to engage a first collet (415), wherein the first clamping plate and the first collet can be placed over an end of the catalytic tube and the first collet, when engaged reduces its inner diameter to establish a first electrical connection with an electrically-conductive layer (230) of the transmission line;

a second clamping plate (420) to engage a second collet (425), wherein the second clamping plate and the second collet can be placed over the end of the catalytic tube and the second collet, when engaged, reduces its inner diameter to establish a second electrical connection with the electrically-conductive, reactive layer (230) of the transmission line; and

a printed circuit board (180a, 180b) located between the first clamping plate and the second clamping plate.

52. The method of claim 46, further comprising:
providing the pulses at a repetition frequency between 1 kHz and 500 kHz with a duty cycle between 0.5% and 50%.
53. The method of claim 52, wherein a rise time of each pulse is between 1 ns and 50 ns.
54. The method of claim 52, wherein a temporal full-width-half-maximum duration of each pulse is between 1 ns and 200 ns.
55. A heating system (100) comprising:
a heater (110, 510) comprising:
an outer shell (119) enclosing a heater chamber (360) to contain a heat-transfer liquid or gas;
a first containment tube (117) extending through the heater chamber and through the outer shell, the first containment tube sealed to prevent ingress of the heat-transfer liquid or gas into the first containment tube; and
a first catalytic tube (170) to generate heat, the first catalytic tube mounted within the first containment tube, the first catalytic tube comprising:
an electrically-conductive layer (220) extending along the first catalytic tube;
an insulating layer (230) disposed on the electrically-conductive layer;
and
an electrically-conductive reactive layer (240) disposed on the insulating layer, wherein the electrically-conductive layer, the insulating layer, and the electrically-conductive reactive layer form a first transmission line (270) that extends along the first catalytic tube,
wherein the first containment tube contacts the heat-transfer liquid or gas when the heater is in operation to thermally couple heat from the first catalytic tube to the heat-transfer liquid or gas when contained in the heater chamber;
a pulse driver (150) adapted to provide electrical pulses to propagate along the first transmission line of the first catalytic tube to generate heat from the first catalytic tube; and
an electrical connector (400) to electrically connect to the first transmission line of the first catalytic tube.

56. The heating system of claim 55, wherein a first impedance of the first transmission line of the first catalytic tube is in a range from 0.1 ohm to 25 ohms.
57. The heating system of claim 56, wherein the first impedance of the first transmission line of the first catalytic tube is approximately or equal to 2 ohms.
58. The heating system of claim 56, wherein:
the pulse driver includes drive electronics (600) implemented at least in part on at least one printed circuit board (PCB) (180a); and
the at least one printed circuit board includes at least one PCB transmission line (185) patterned on the at least one PCB to carry the electrical pulses provided by the pulse driver.
59. The heating system of claim 58, wherein the at least one PCB transmission line is impedance-matched to the first transmission line of the first catalytic tube.
60. The heating system of claim 59, wherein a second impedance of the at least one PCB transmission line is within 10% of the first impedance of the first transmission line over a range of frequencies from approximately or exactly 250 MHz to approximately or exactly 2 GHz.
61. The heating system of claim 58, wherein:
the drive electronics are configured to receive optical pulses; and
the drive electronics are configured to convert the received optical pulses to provide the electrical pulses from the pulse driver to propagate along the first transmission line of the first catalytic tube.
62. The heating system of claim 58, wherein the electrical connector comprises:
a first clamping plate (410) to engage a first collet (415), wherein the first clamping plate and the first collet can be placed over an end of the first catalytic tube; and
a second clamping plate (420) to engage a second collet (425), wherein the second clamping plate and the second collet can be placed over the end of the first catalytic tube,

wherein the first collet and the second collet facilitate an electrical connection between the at least one PCB transmission line patterned on the at least one PCB and the first transmission line of the first catalytic tube.

63. The heating system of claim 62, wherein:

the at least one printed circuit board of the drive electronics includes:

a first annular contact (188) disposed on a first side of the at least one printed circuit board; and

a second annular contact (188) disposed on a second side of the at least one printed circuit board;

the first annular contact and the second annular contact are coupled to the at least one PCB transmission line; and

the first collet is electrically coupled to the first annular contact by the first clamping plate and the second collet is electrically coupled to the second annular contact by the second clamping plate to facilitate the electrical connection between the at least one PCB transmission line and the first transmission line of the first catalytic tube.

64. A heater (110, 510) for a heating system (100), the heater comprising:

an outer shell (119) enclosing a heater chamber (360) to contain a heat-transfer liquid or gas;

a first containment tube (117) extending through the heater chamber and through the outer shell, the first containment tube sealed to prevent ingress of the heat-transfer liquid or gas into the first containment tube; and

a first catalytic tube (170) to generate heat, the first catalytic tube mounted within the first containment tube, the first catalytic tube comprising a first transmission line (270) that extends along the first catalytic tube,

wherein:

the first containment tube contacts the heat-transfer liquid or gas when the heater is in operation to thermally couple heat from the first catalytic tube to the heat-transfer liquid or gas when contained in the heater chamber; and

an outer diameter of the first catalytic tube is smaller than an inner diameter of the first containment tube so as to form a reactant space (250) between an outer surface of the

first catalytic tube and an inner surface of the first containment tube, such that a reactant, when present in the heater, flows through the reactant space.

65. The heater of claim 64, wherein the first containment tube comprises:
a tubular portion (317);
a first insert (373) to insert into a first end of the tubular portion; and
a second insert (373) to insert into a second end of the tubular portion,
wherein the first insert and the second insert are configured to support the first catalytic tube within the first containment tube.
66. The heater of claim 65, wherein the first insert and the second insert each comprise:
a ferule (375); and
a nut (370) to engage the ferule to support the first catalytic tube within the first containment tube.
67. The heater of claim 64, further comprising a porous, electrically insulating, and thermally-conductive fill within the reactant space.
68. The heater of claim 64, further comprising:
a second containment tube extending through the heater chamber and through the outer shell; and
a second catalytic tube mounted within the second containment tube.
69. The heater of claim 68, further comprising:
a manifold (114) to receive the reactant and supply the reactant into a first interior of the first containment tube and a second interior of the second containment tube.
70. The heater of claim 69, wherein:
the manifold includes a chamber (310) and is integrated onto an end of the heater such that each of the first containment tube and the second containment tube passes through the manifold; and
each of the first containment tube and the second containment tube includes a hole (312) located within the chamber of the manifold to admit the reactant, when present, into the

first interior of the first containment tube and the second interior of the second containment tube.

71. The heater of claim 64, in combination with a pulse driver (150) adapted to provide electrical pulses to propagate along the first transmission line of the first catalytic tube to generate heat from the first catalytic tube.

72. The heater of claim 64, further comprising an electrical connector (400) to electrically connect to the first transmission line of the first catalytic tube.

73. A heating system (100) comprising:

a heater (110, 510) comprising:

an outer shell (119) enclosing a heater chamber (360) to contain a heat-transfer liquid or gas;

a first containment tube (117) extending through the heater chamber and through the outer shell, the first containment tube sealed to prevent ingress of the heat-transfer liquid or gas into the first containment tube, wherein the first containment tube comprises:

a tubular portion (317);

a first insert (373) to insert into a first end of the tubular portion; and

a second insert (373) to insert into a second end of the tubular portion,

wherein the first insert and the second insert are configured to support

the first catalytic tube within the first containment tube; and

a first catalytic tube (170) to generate heat, the first catalytic tube mounted within the first containment tube, the first catalytic tube comprising a first transmission line (270) that extends along the first catalytic tube,

wherein the first containment tube contacts the heat-transfer liquid or gas when the heater is in operation to thermally couple heat from the first catalytic tube to the heat-transfer liquid or gas when contained in the heater chamber;

a pulse driver (150) adapted to provide electrical pulses to propagate along the first transmission line of the first catalytic tube to generate heat from the first catalytic tube, wherein:

the pulse driver includes drive electronics (600) implemented at least in part on at least one printed circuit board (PCB) (180a); and

the at least one printed circuit board includes at least one PCB transmission line (185) patterned on the at least one PCB to carry the electrical pulses provided by the pulse driver; and

an electrical connector (400) to electrically connect to the first transmission line of the first catalytic tube, the electrical connector including a first collet and a second collet to facilitate an electrical connection between the at least one PCB transmission line patterned on the at least one PCB and the first transmission line of the first catalytic tube.

74. The heating system of claim 73, wherein a first impedance of the first transmission line of the first catalytic tube is in a range from 0.1 ohm to 25 ohms.

75. The heating system of claim 74, wherein the at least one PCB transmission line is impedance-matched to the first transmission line of the first catalytic tube.

76. The heating system of claim 75, wherein the electrical connector comprises:
a first clamping plate (410) to engage the first collet (415), wherein the first clamping plate and the first collet can be placed over an end of the first catalytic tube; and
a second clamping plate (420) to engage the second collet (425), wherein the second clamping plate and the second collet can be placed over the end of the first catalytic tube.

77. In a heater (110, 510) for a heating system (100), the heater comprising an outer shell (119) enclosing a heater chamber (360) to contain a heat-transfer liquid or gas, the improvement comprising:

a first containment tube (117) extending through the heater chamber and through the outer shell, the first containment tube sealed to prevent ingress of the heat-transfer liquid or gas into the first containment tube; and

a first catalytic tube (170) to generate heat, the first catalytic tube mounted within the first containment tube, the first catalytic tube comprising multiple coaxial layers forming a first transmission line (270) that extends along the first catalytic tube,

wherein the first containment tube contacts the heat-transfer liquid or gas when the heater is in operation to thermally couple heat from the first catalytic tube to the heat-transfer liquid or gas when contained in the heater chamber.

78. The heater of claim 77, wherein an impedance of the first transmission line of the first catalytic tube is a value in a range from 0.1 ohm to 25 ohms.

79. The heater of claim 77, wherein the multiple coaxial layers comprise:
an electrically-conductive layer (220) extending along the first catalytic tube;
an insulating layer (230) disposed on the electrically-conductive layer; and
an electrically-conductive reactive layer (240) disposed on the insulating layer.

80. The heater of claim 79, wherein:
the first catalytic tube further comprises a cylindrical support (210), wherein the cylindrical support comprises one of a metal, a ceramic, and a glass; and
the electrically-conductive reactive layer is disposed relative to an outside surface of the cylindrical support.

81. The heater of claim 79, wherein:
the electrically-conductive layer comprises at least one of copper or aluminum;
the insulating layer comprises alumina; and
the electrically-conductive reactive layer comprises at least one of nickel, grainy nickel, copper, palladium, platinum, rhodium, titanium, tungsten, cobalt, or iron.

82. The heater of claim 81, wherein:
the electrically-conductive layer has a first thickness of between 1 micron and 500 microns;
the insulating layer has a second thickness of between 100 microns and 400 microns;
and
the electrically-conductive reactive layer has a third thickness of between 200 microns and 900 microns.

83. The heater of claim 77, in combination with a pulse driver (150) adapted to provide electrical pulses to propagate along the first transmission line of the first catalytic tube to generate heat from the first catalytic tube.

84. The heater of claim 77, in combination with an electrical connector (400) to electrically connect to the first transmission line of the first catalytic tube.

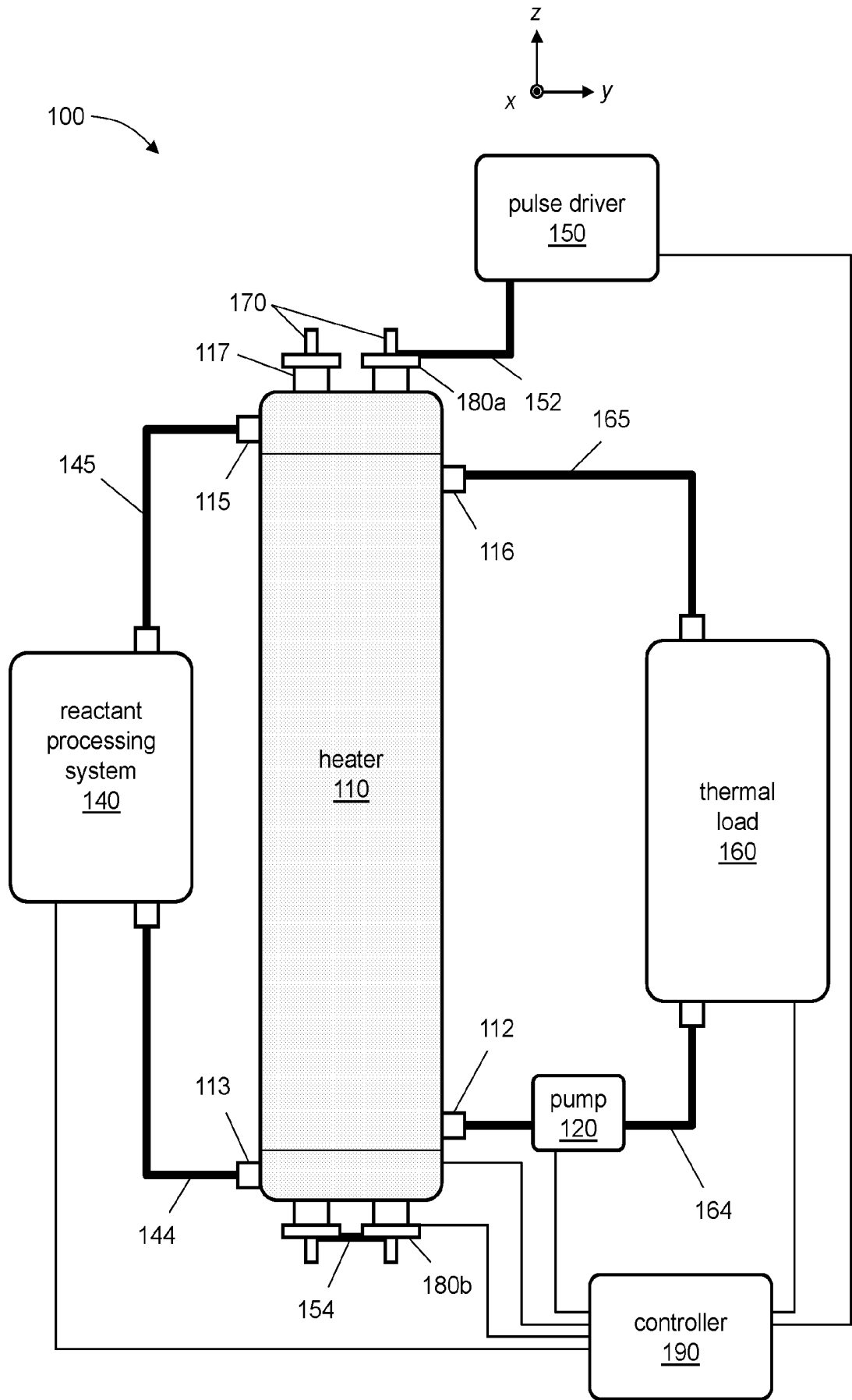


FIG. 1A

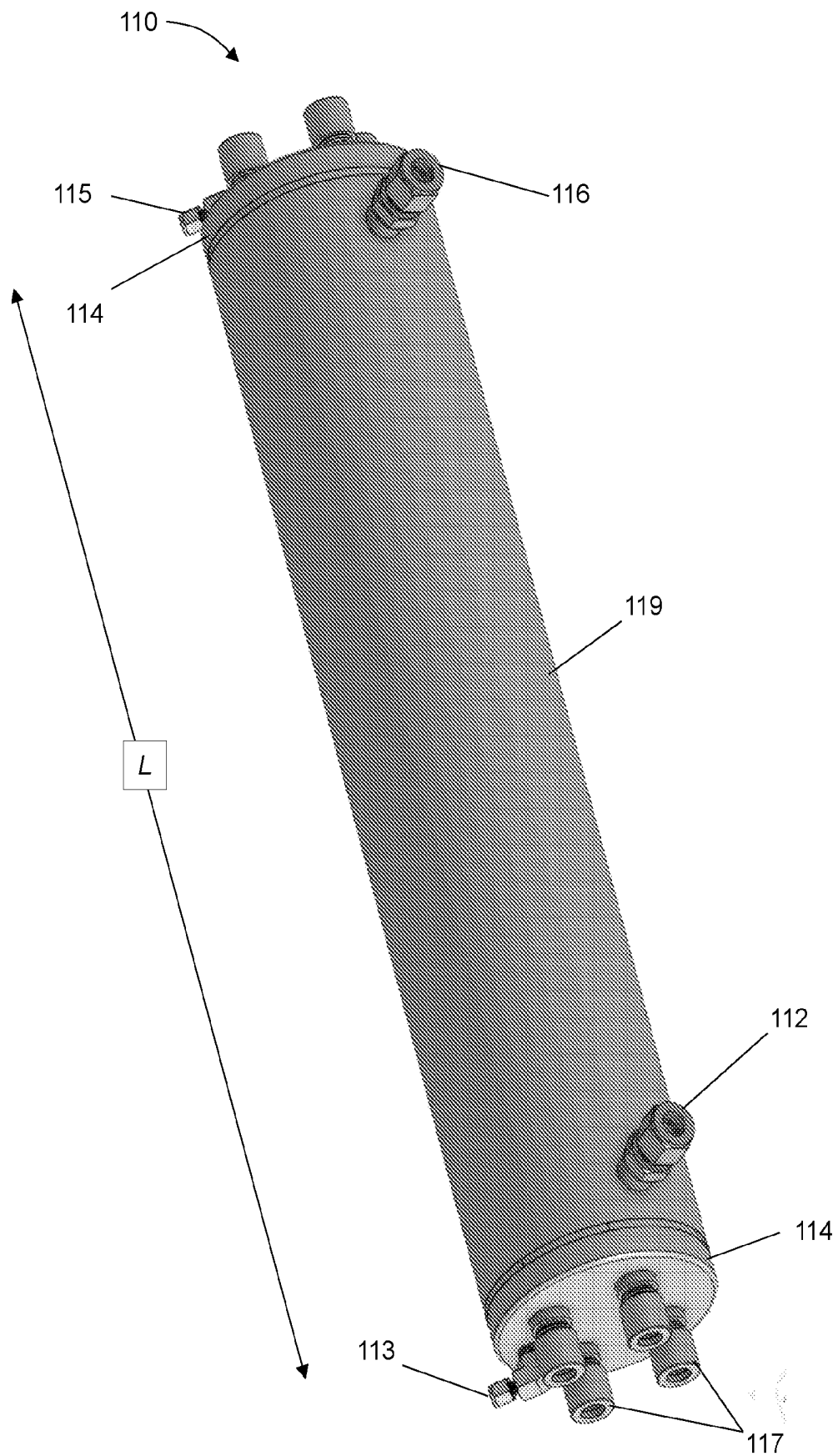


FIG. 1B

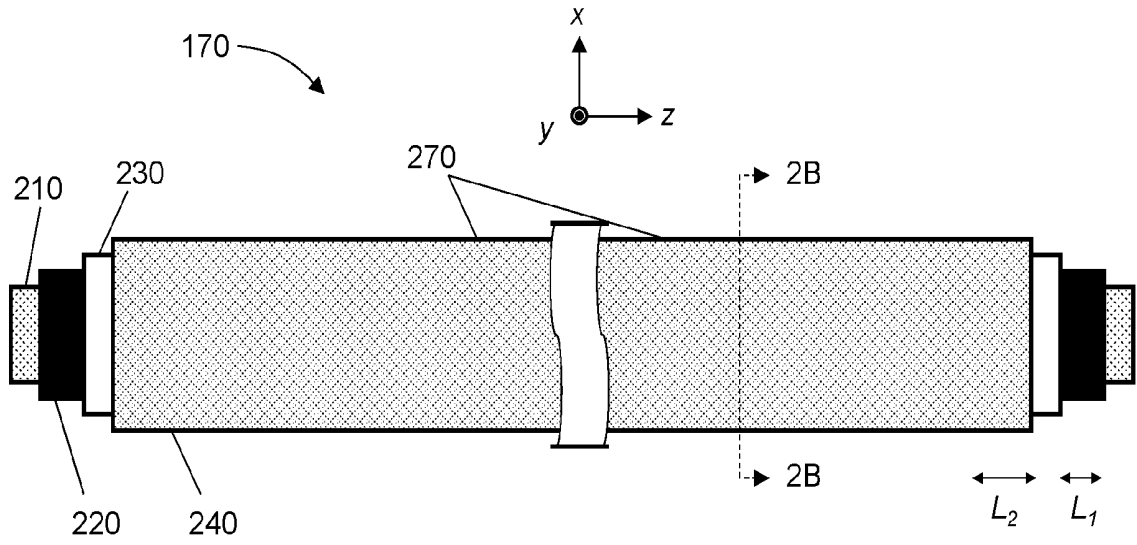


FIG. 2A

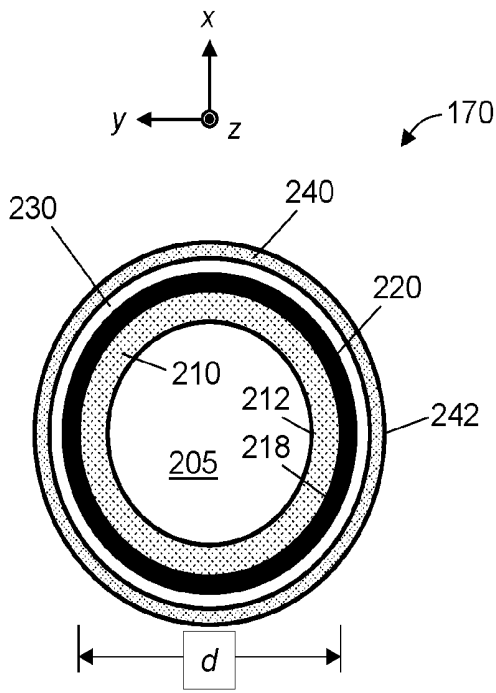


FIG. 2B

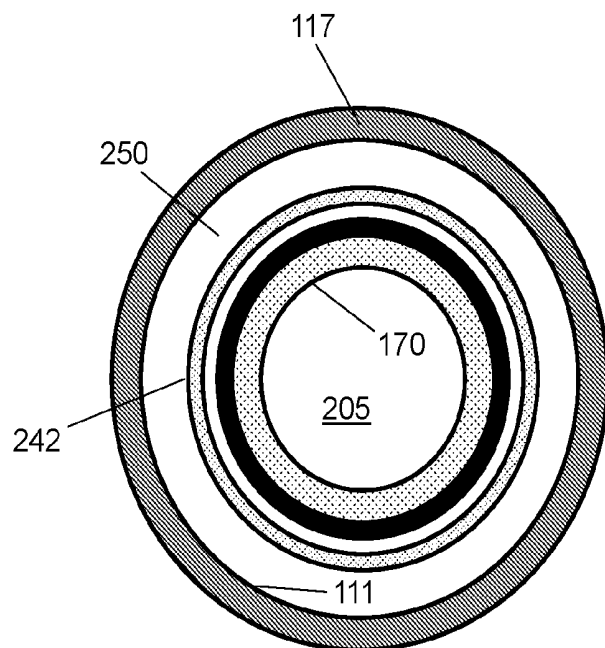


FIG. 2C

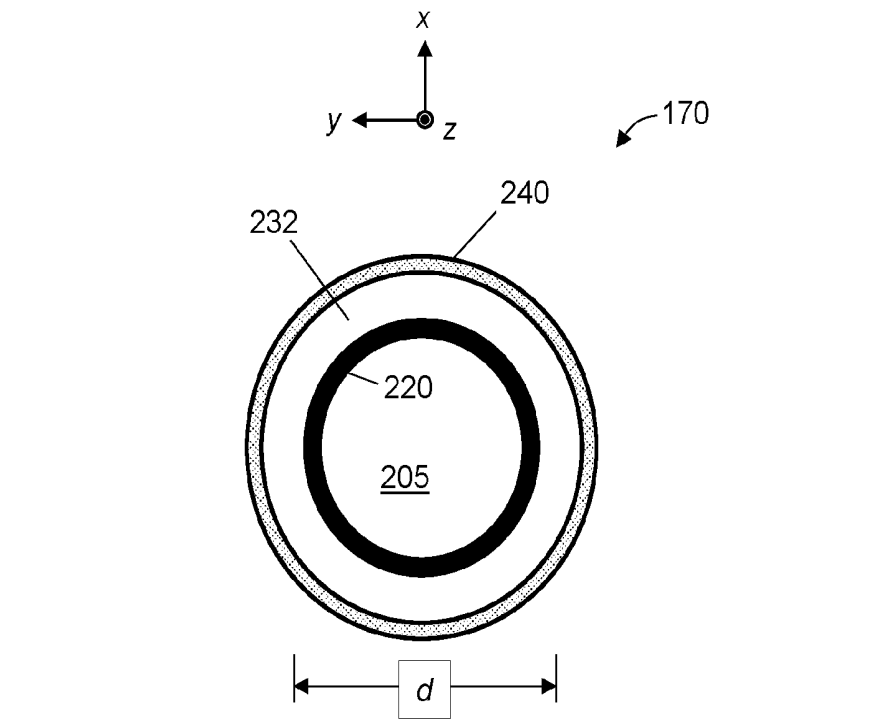


FIG. 2D

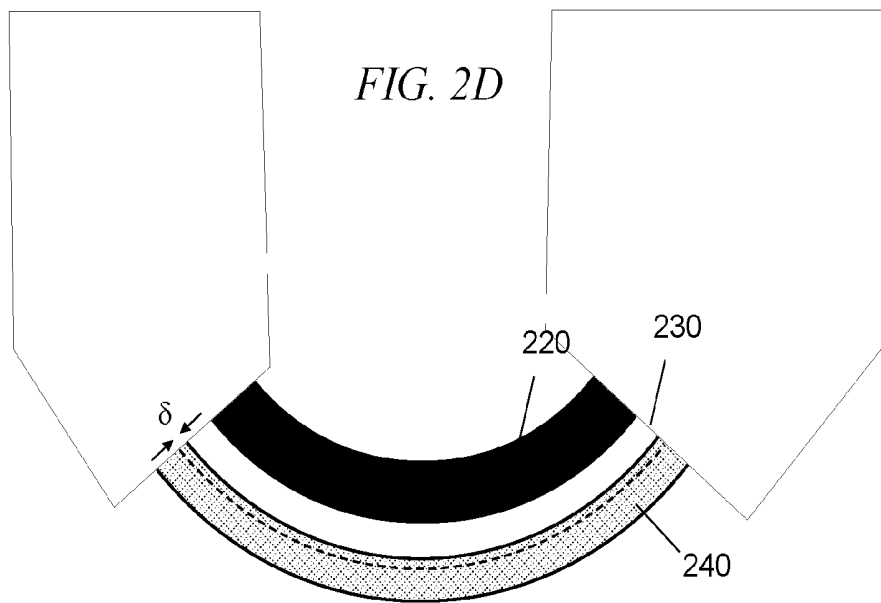


FIG. 2E

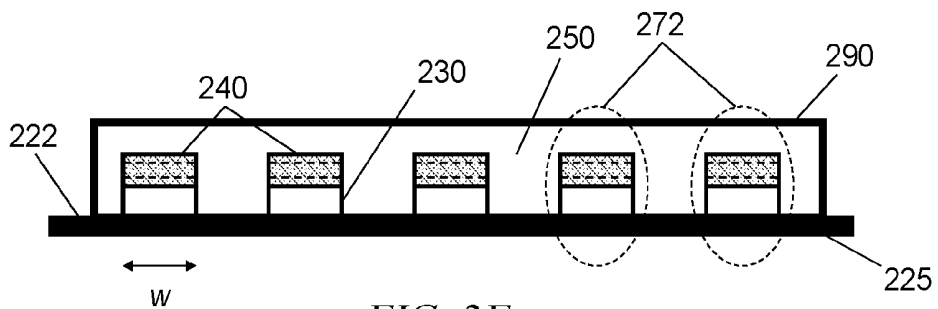


FIG. 2F

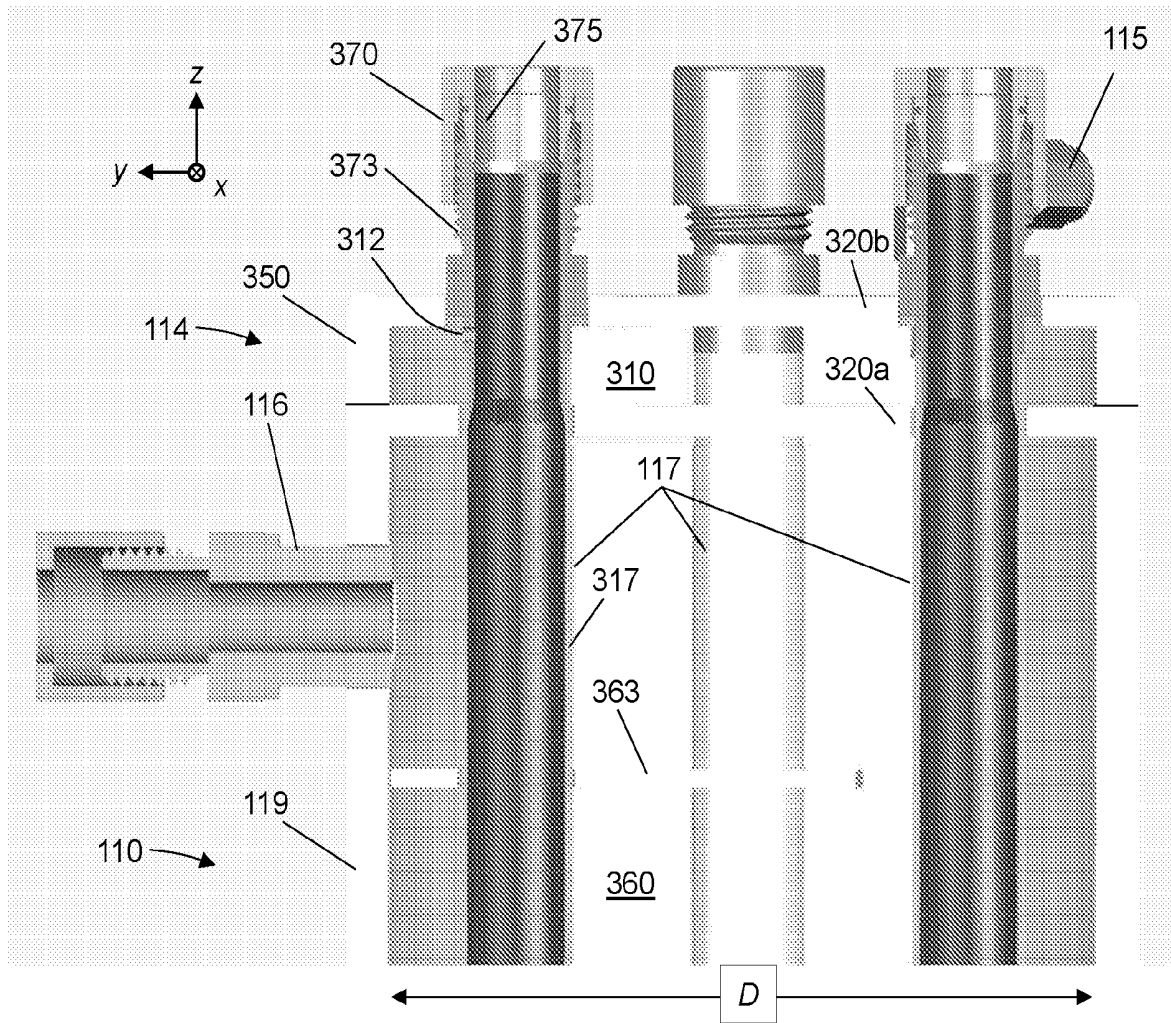


FIG. 3A

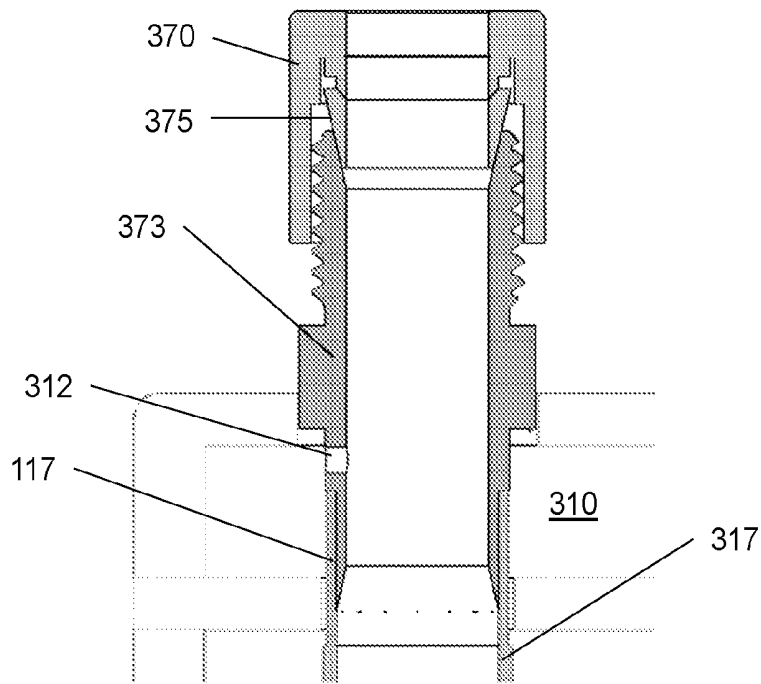


FIG. 3B

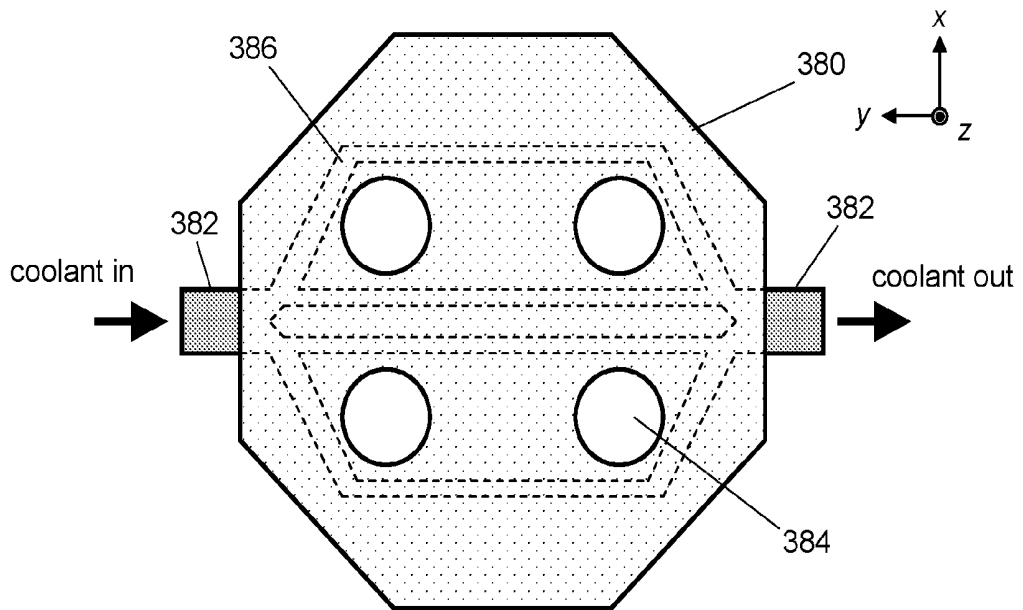


FIG. 3C

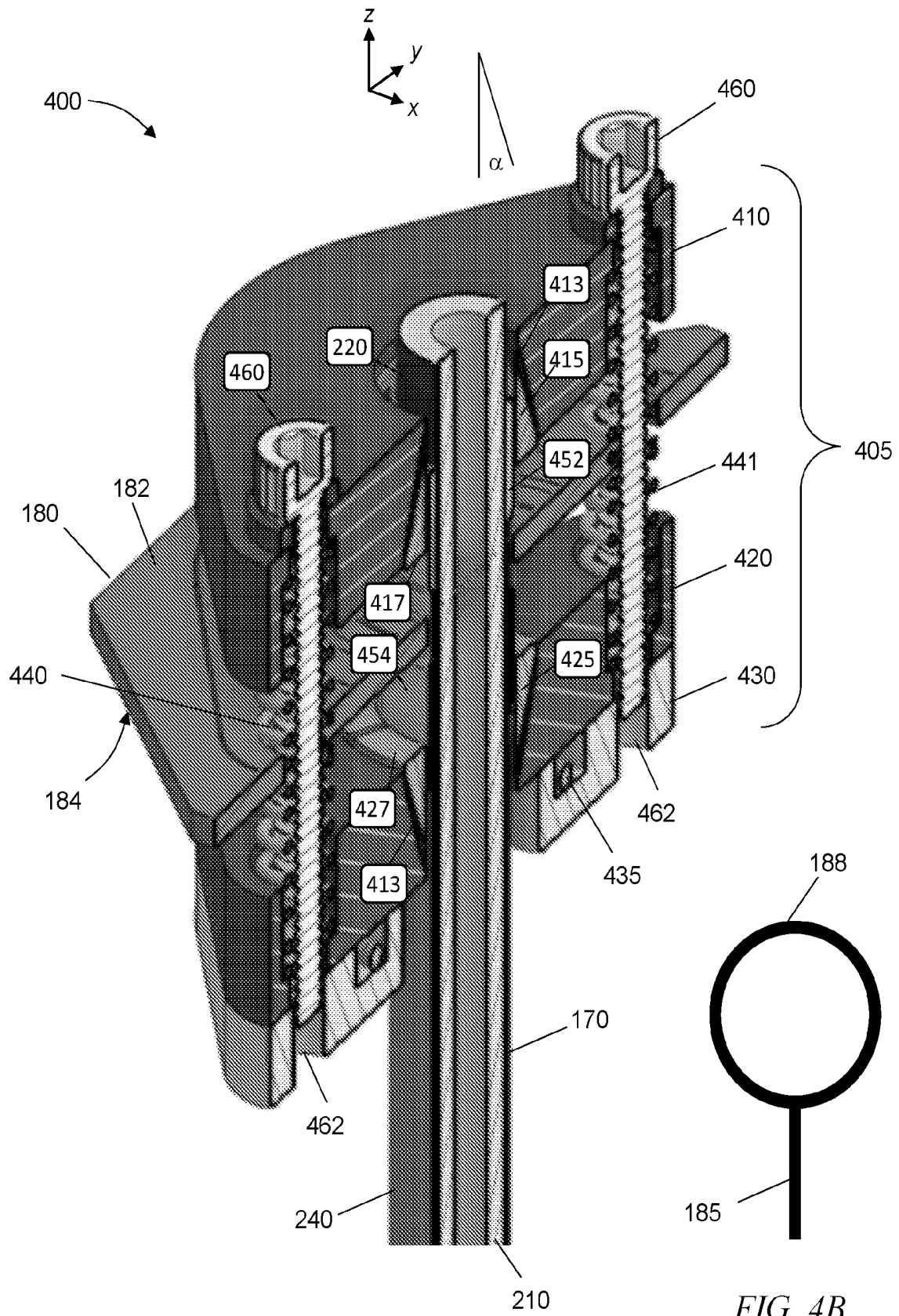


FIG. 4A

FIG. 4B

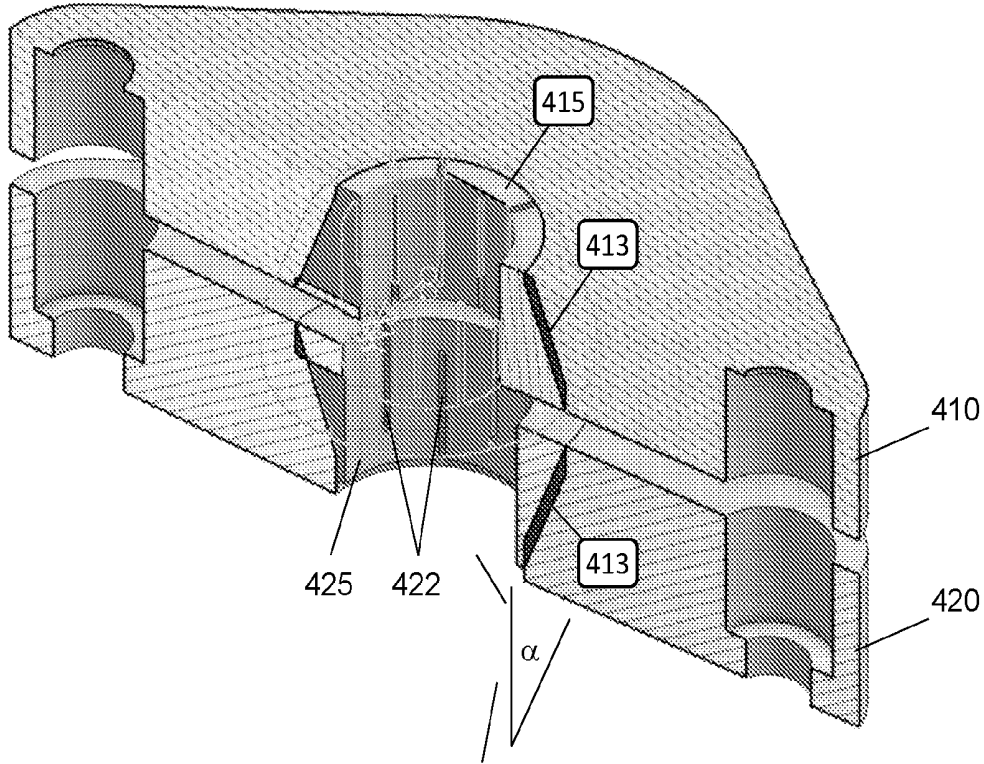
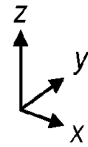


FIG. 4C

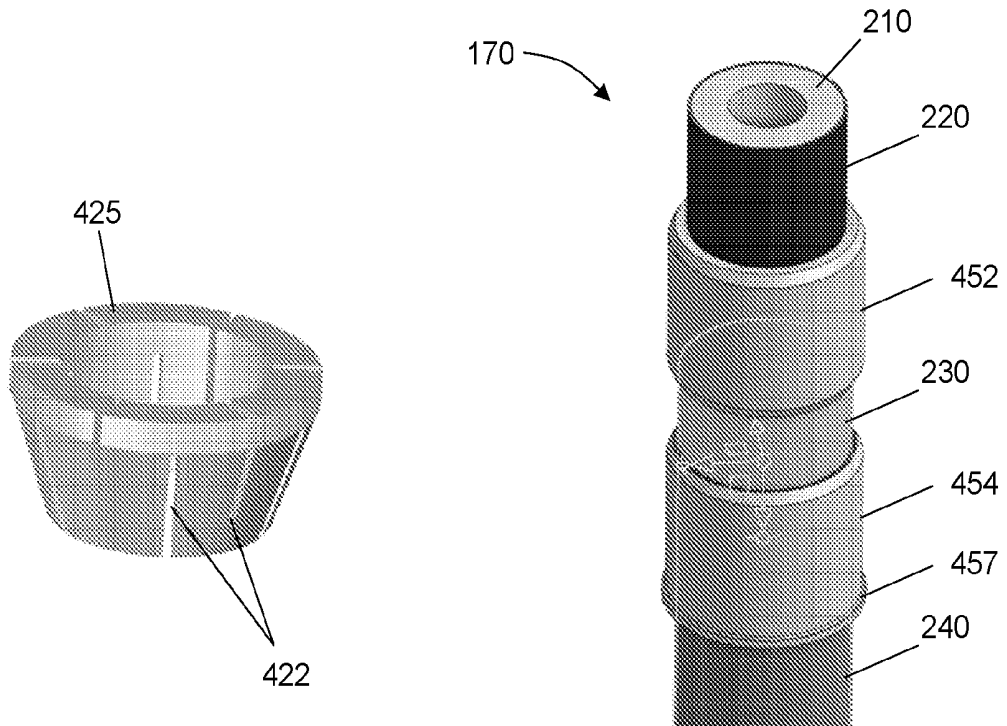


FIG. 4D

FIG. 4E

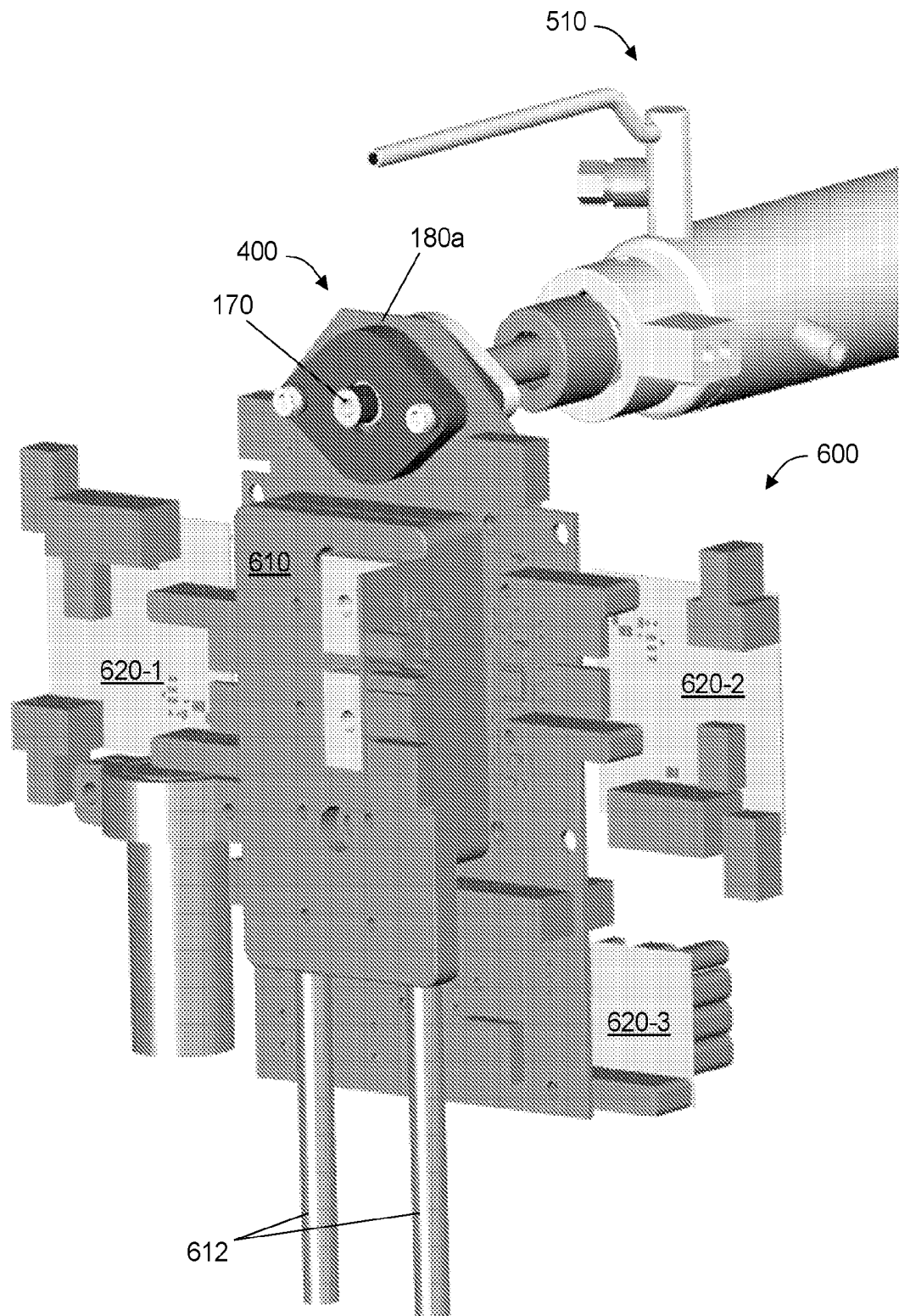


FIG. 6A

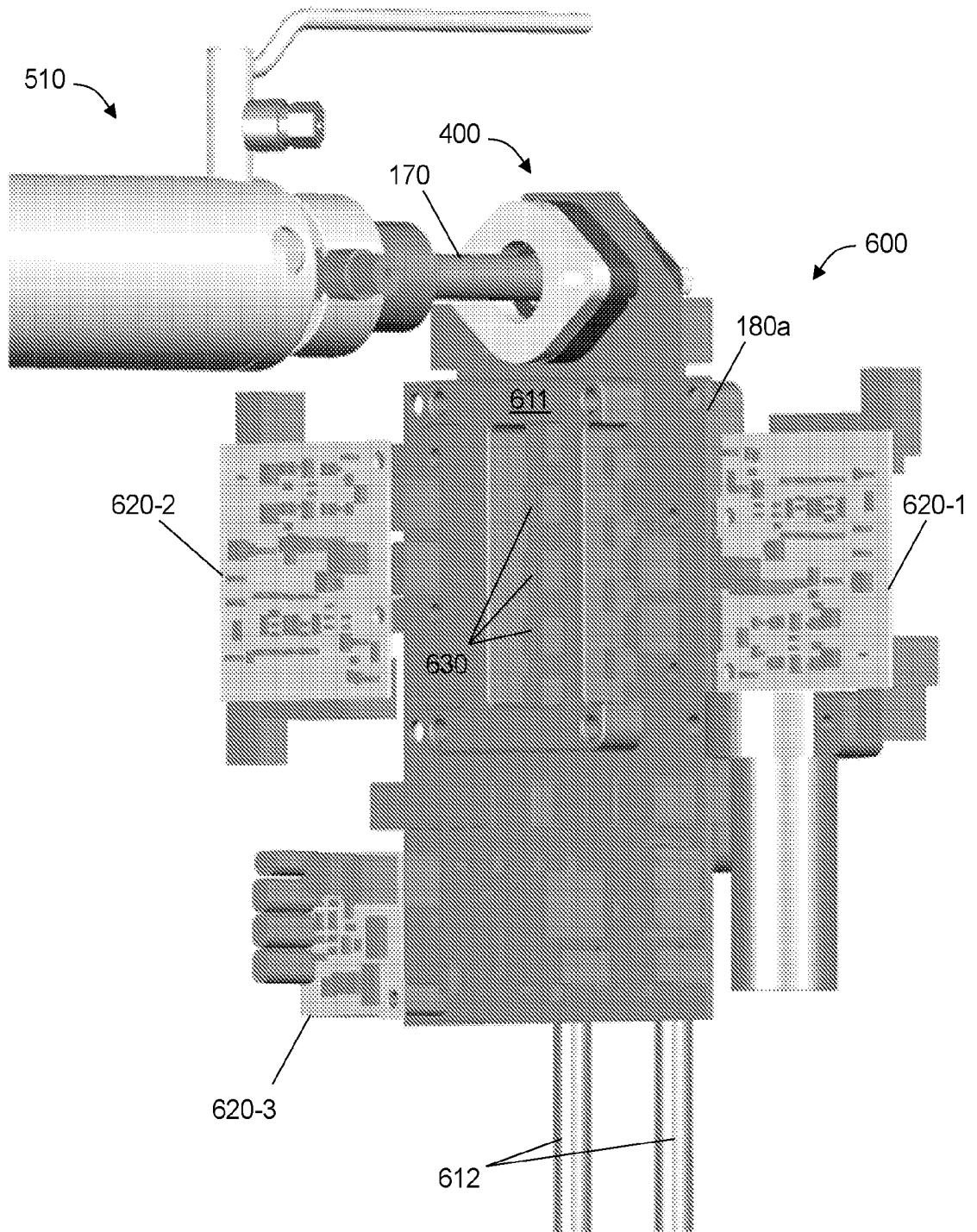


FIG. 6B

700 →

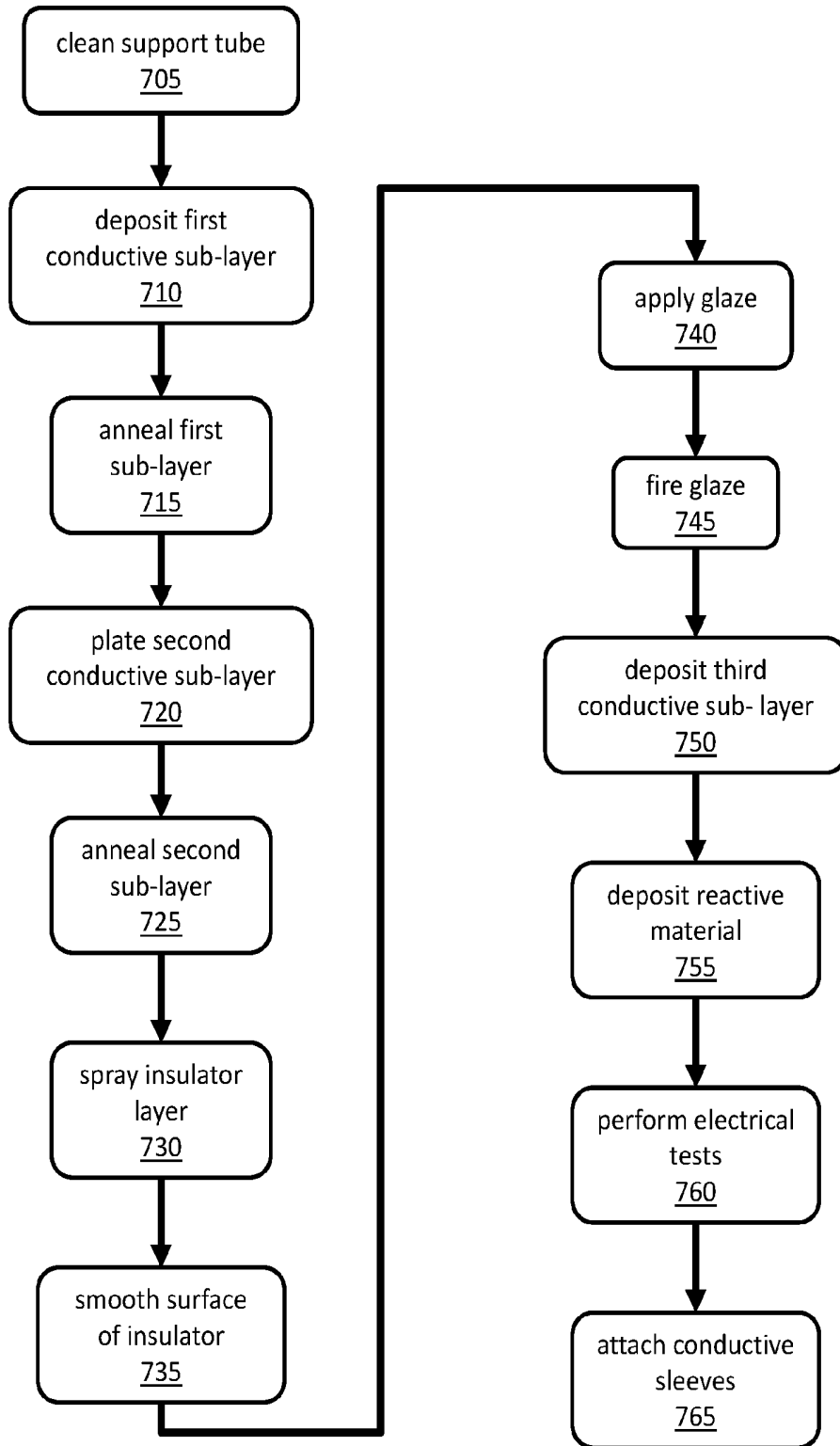


FIG. 7

INTERNATIONAL SEARCH REPORT

International application No.

PCT/US2025/031186

A. CLASSIFICATION OF SUBJECT MATTER

IPC: **H05B 3/10** (2025.01); **F16L 9/14** (2025.01); **F24H 1/10** (2025.01); **H05B 1/00** (2025.01); **H05B 3/40** (2025.01); **H05B 3/44** (2025.01); **F01N 3/28** (2025.01); **B01J 35/00** (2025.01)

CPC: **H05B 3/10**; **F16L 9/14**; **F24H 1/101**; **H05B 1/00**; **H05B 3/0023**; **H05B 3/40**; **H05B 3/44**; **F01N 3/28**; **B01J 35/00**; **F24H 1/10**

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

See Search History Document

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

See Search History Document

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

See Search History Document

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 2023/0358156 A1 (UNIFRAX I LLC) 09 November 2023 (09.11.2023) para [0017]-[0019], [0032]	1-34
A	US 2010/0206415 A1 (ELLIS ET AL.) 19 August 2010 (19.08.2010) para [0040]	1-34
A	US 2023/0158464 A1 (SCHNEIDER ELECTRIC SYSTEMS USA, INC. ET AL.) 25 May 2023 (25.05.2023) para [0023]	1-34
X,P	WO 2024/250033 A2 (BRILLOUIN ENERGY CORP.) 05 December 2024 (05.12.2024) para [0018]-[0020], [0144]-[0151]	1, 29
A	US 2022/0259056 A1 (Haldor Topsoe A/S) 18 August 2022 (18.08.2022) para [0166]-[0170]	1-34

Further documents are listed in the continuation of Box C.

See patent family annex.

* Special categories of cited documents:

“A” document defining the general state of the art which is not considered to be of particular relevance

“D” document cited by the applicant in the international application

“E” earlier application or patent but published on or after the international filing date

“L” document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)

“O” document referring to an oral disclosure, use, exhibition or other means

“P” document published prior to the international filing date but later than the priority date claimed

“T” later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention

“X” document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

“Y” document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art

“&” document member of the same patent family

Date of the actual completion of the international search

03 September 2025 (03.09.2025)

Date of mailing of the international search report

15 September 2025 (15.09.2025)

Name and mailing address of the ISA/US

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Box No. III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

This International Searching Authority found multiple inventions in this international application, as follows:

This application contains the following inventions or groups of inventions which are not so linked as to form a single general inventive concept under PCT Rule 13.1. In order for all inventions to be searched, the appropriate additional search fees must be paid.

Group I: Claims 1-34 drawn to electrically connecting to a transmission line including a clamping plate.

Group II: Claims 35-45, drawn to a method of making a transmission line including first and second conductive sub-layers.

Group III: Claims 46-84, drawn to a heating system including a containment tube and heat-transfer fluid.

The inventions listed in the above-mentioned groups do not relate to a single general inventive concept under PCT Rule 13.1 because, under PCT Rule 13.2, they lack the same or corresponding special technical features for the following reasons:

Special Technical Features:

Group I includes the special technical feature of a clamping plate, not included in the other groups.

Group II includes the special technical feature of first and second conductive sub-layers, not included in the other groups.

Group III includes the special technical feature of a containment tube and heat-transfer fluid, not included in the other groups.

Common Technical Features:

The only technical feature shared by Groups I-III that would otherwise unify the groups, is a catalytic tube including an electrically conductive layer and a reactive material. However, this shared technical feature does not represent a contribution over prior art, because the shared technical feature is disclosed by US 2023/0358156 A1 to UNIFRAX I LLC. (hereinafter Unifrax).

The only additional technical feature shared by Groups I and II that would otherwise unify the groups is an insulating layer. However, this shared technical feature does not represent a contribution over prior art, because the shared technical feature is disclosed by Unifrax.

The only additional technical feature shared by Groups II and III that would otherwise unify the groups is generating heat. However, this shared technical feature does not represent a contribution over prior art, because the shared technical feature is disclosed by Unifrax.

Unifrax discloses a catalytic tube (a catalytic element 100) including an electrically conductive layer (conductive layer 14) and a reactive material (fiber-supported catalytic layer 10), and insulating layer (isolator 40) and generating heat (inductive heater 12) (Fig 1; para [0017]-[0018], [0032]).

Accordingly, the inventions listed as the above Groups lack unity of invention under PCT Rule 13 because they do not share a same or corresponding special technical feature providing a contribution over prior art.

INTERNATIONAL SEARCH REPORT

International application No.

PCT/US2025/031186

Box No. III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

1. As all required additional search fees were timely paid by the applicant, this international search report covers all searchable claims.
2. As all searchable claims could be searched without effort justifying additional fees, this Authority did not invite payment of additional fees.
3. As only some of the required additional search fees were timely paid by the applicant, this international search report covers only those claims for which fees were paid, specifically claims Nos.:
4. No required additional search fees were timely paid by the applicant. Consequently, this international search report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.: **1-34**

Remark on Protest

- The additional search fees were accompanied by the applicant's protest and, where applicable, the payment of a protest fee.
- The additional search fees were accompanied by the applicant's protest but the applicable protest fee was not paid within the time limit specified in the invitation.
- No protest accompanied the payment of additional search fees.